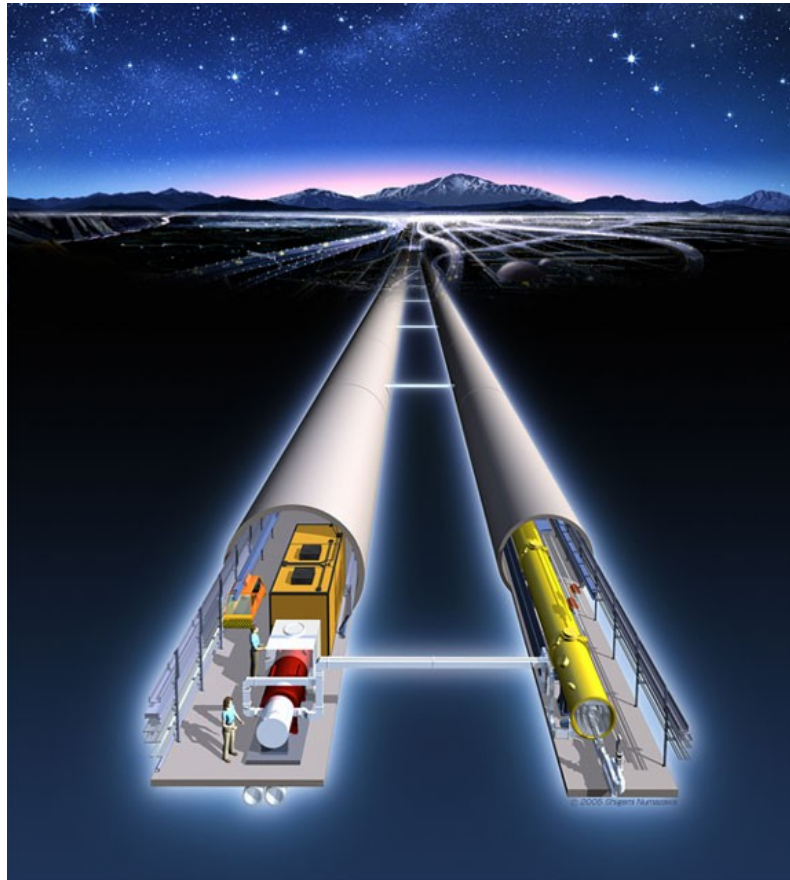


# Summary of CFS MDI Mini-Workshop

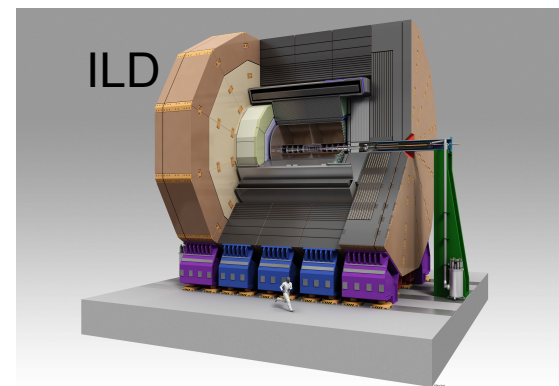
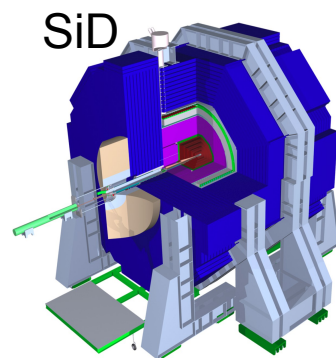
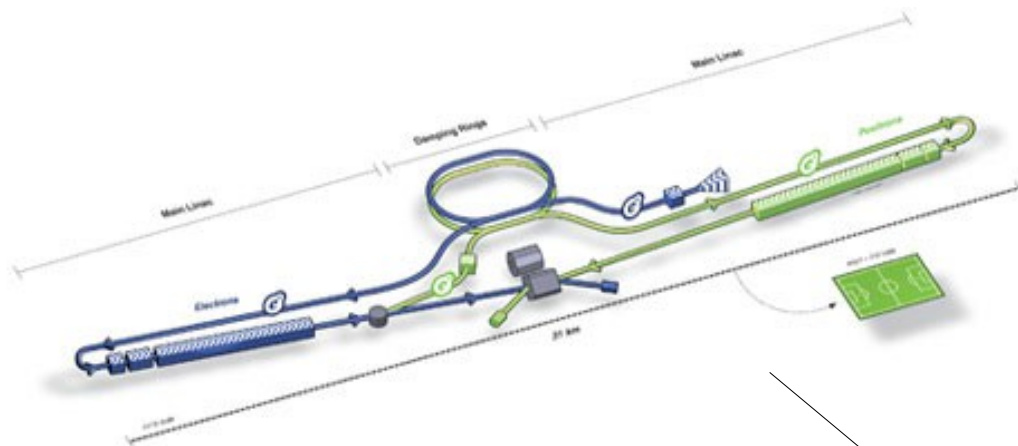
15/3/16 – 16/3/16 at KEK

<http://agenda.linearcollider.org/event/6910/other-view?view=standard>

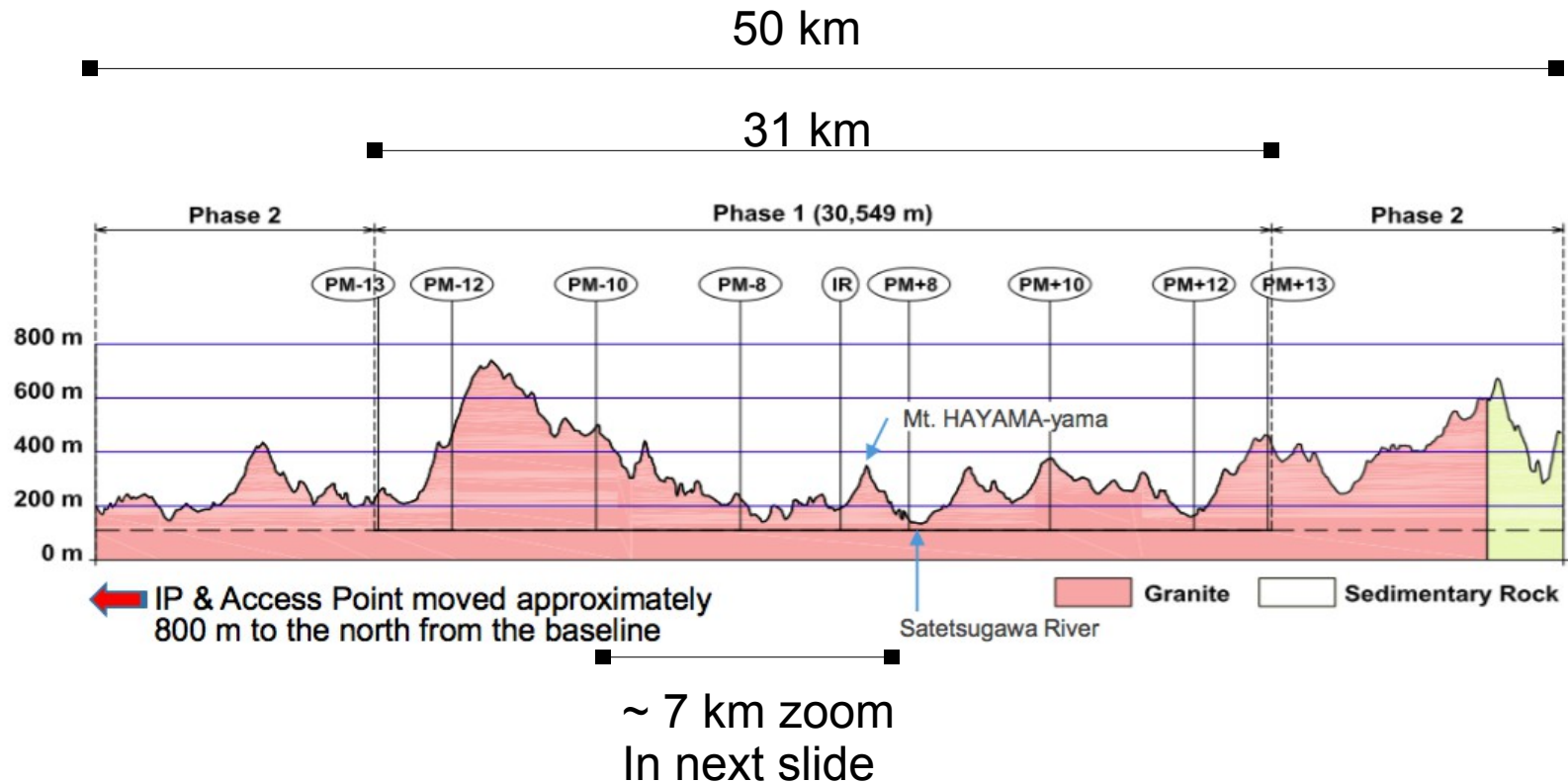


Roman Pöschl



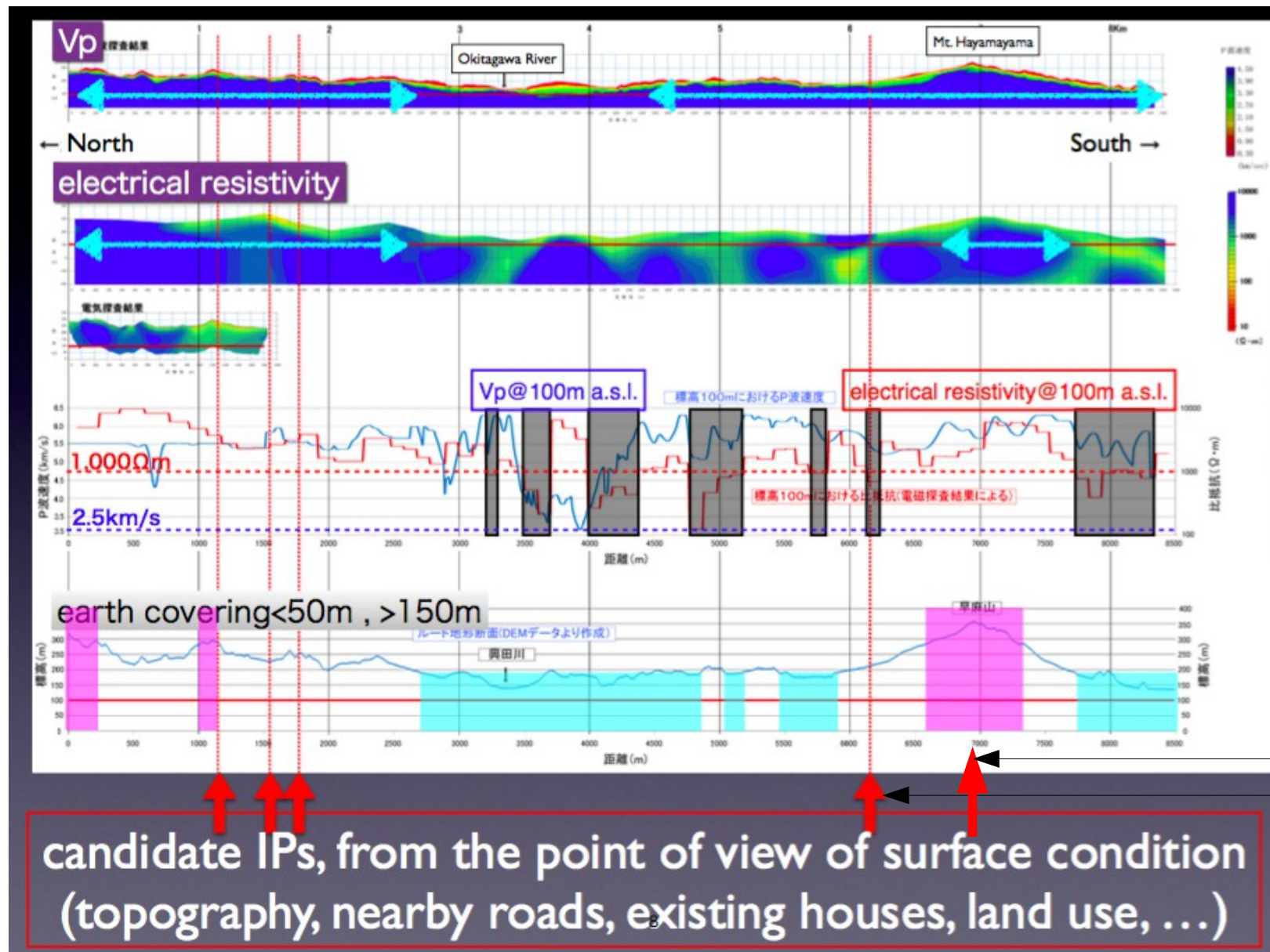


## Longitudinal section of Kitakami site



Masanobu Miyahara, ALCW15

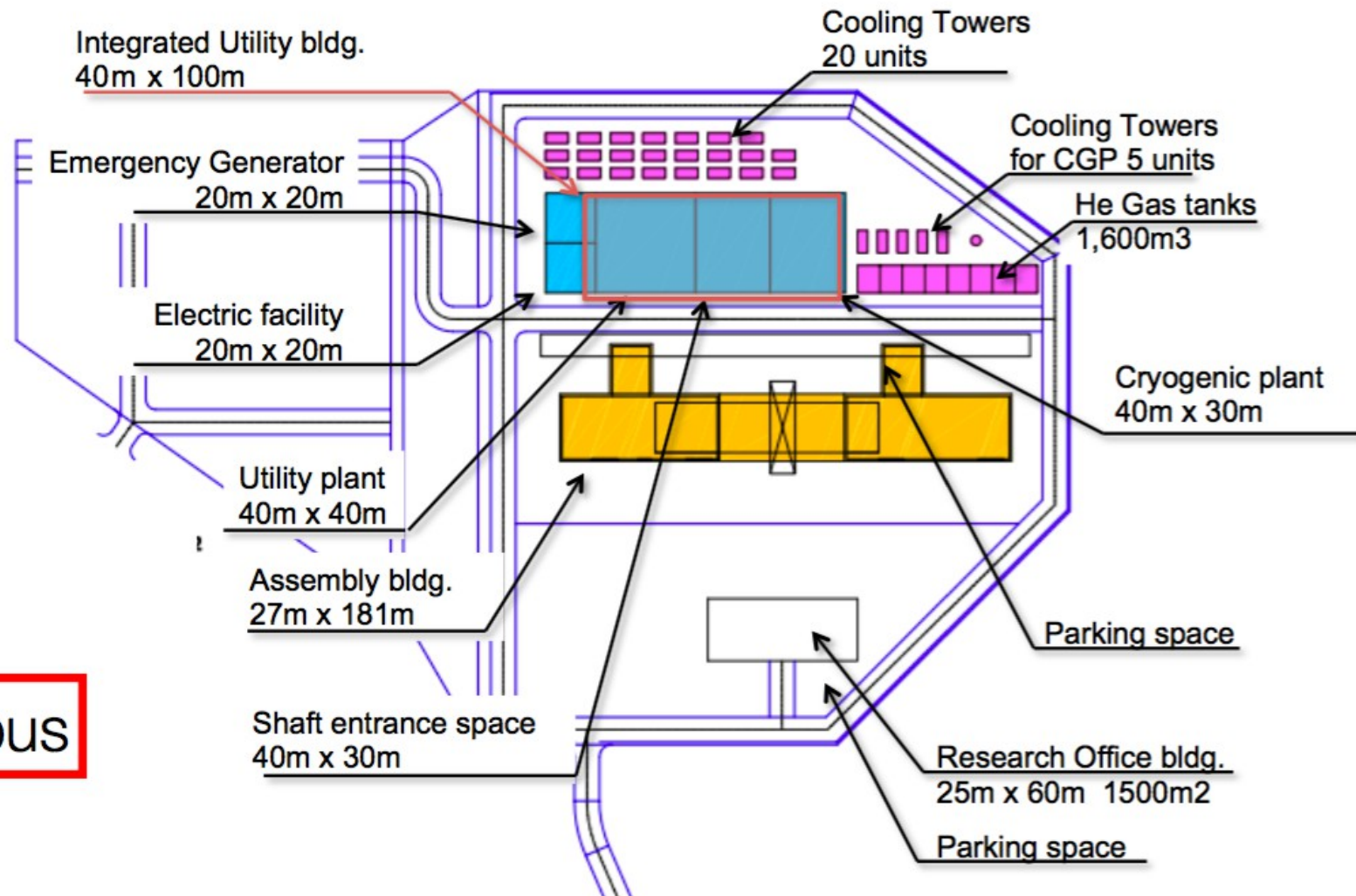




very  
old IP  
Old IP

Tomo Sanuki (Tohoku) New IP candidates seem to have better geological conditions

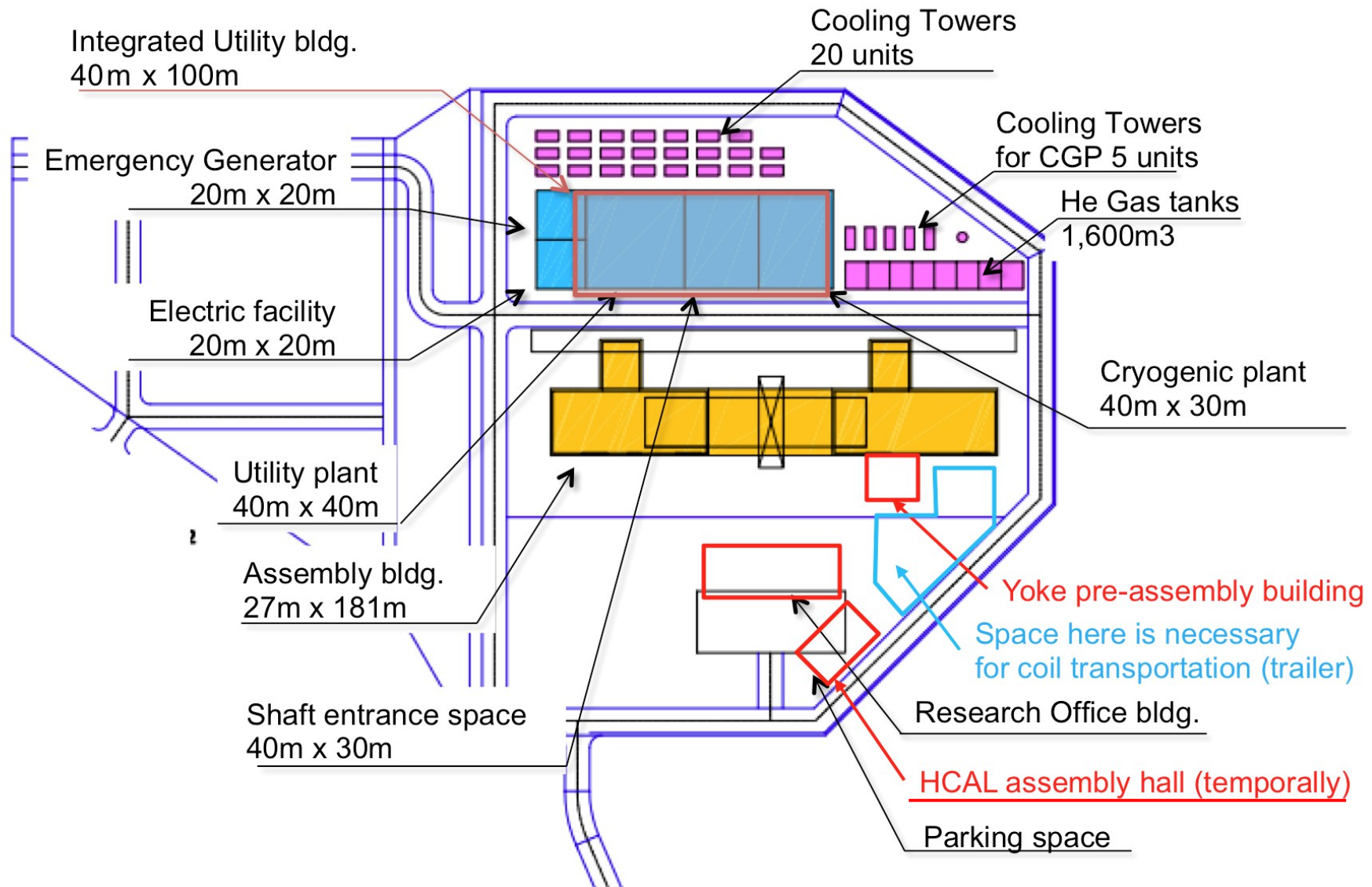
First idea by Sugimoto-san for original IP



IP Campus

About 60000 m<sup>2</sup>

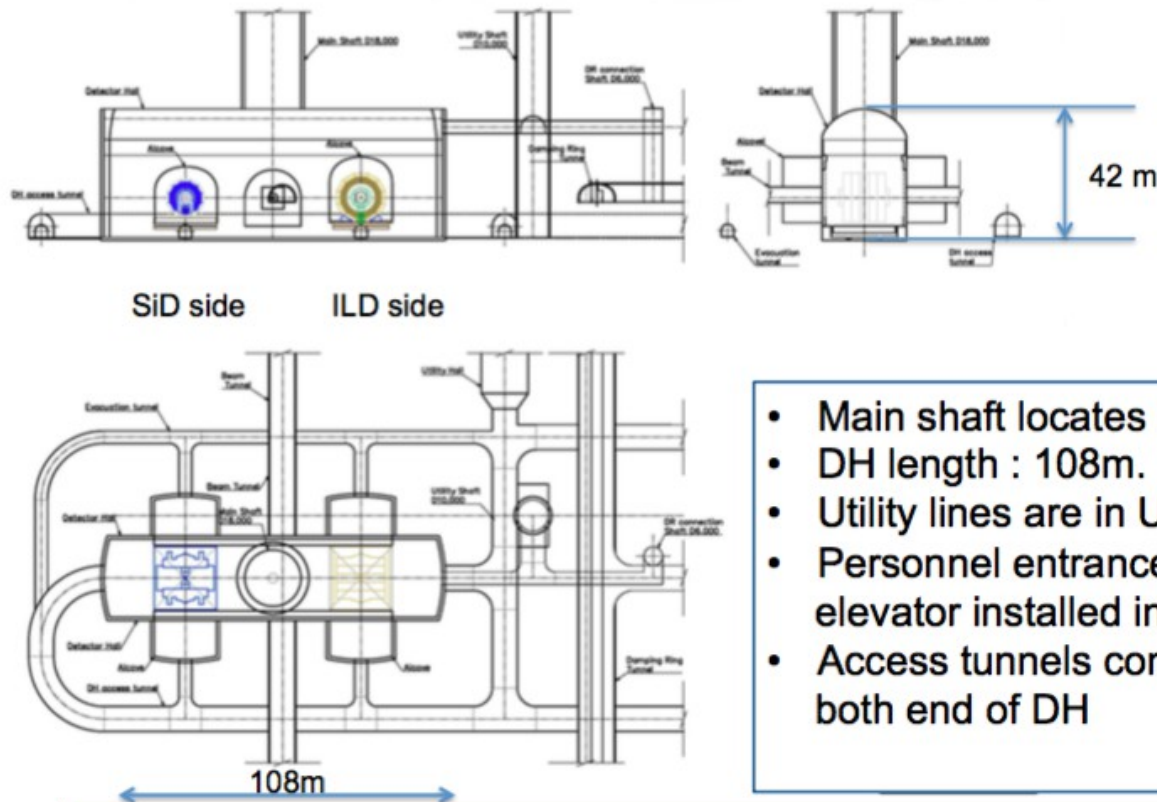
First idea by Sugimoto-san for original IP + additional buildings





## Current Design of Detector Hall

Slide from Y. Nishimoto



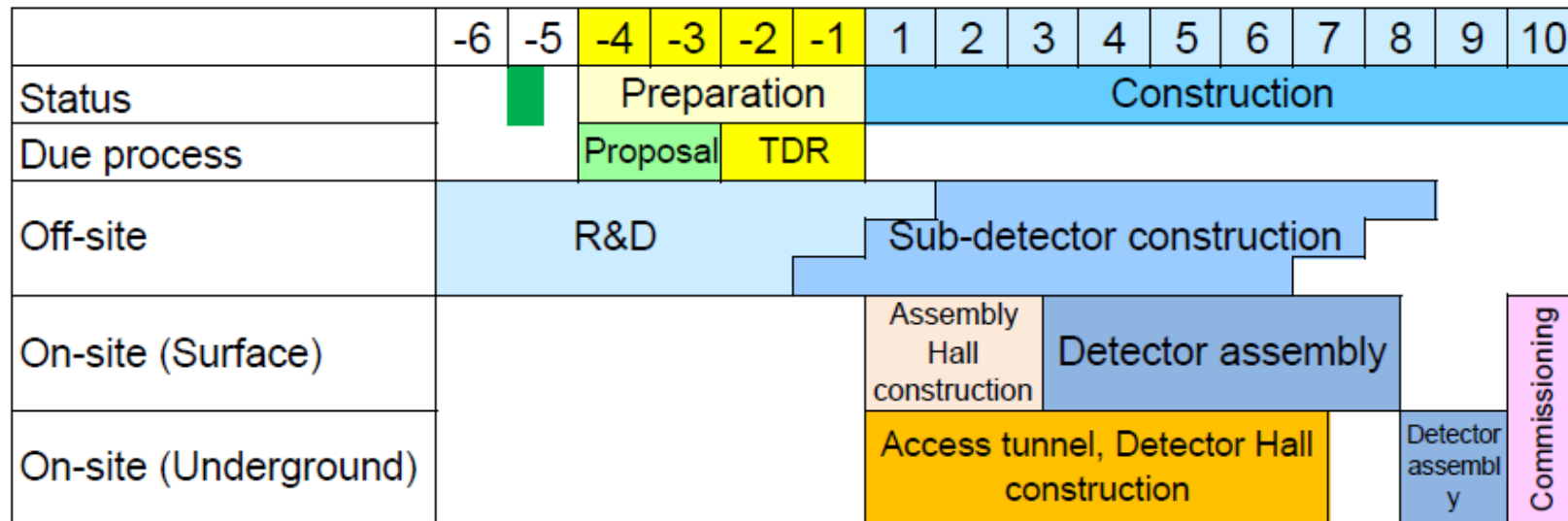
- Main shaft locates IR position.
- DH length : 108m.
- Utility lines are in UT shaft
- Personnel entrance way is elevator installed in UT shaft
- Access tunnels connect at the both end of DH

CFS@KEK.ilc

4

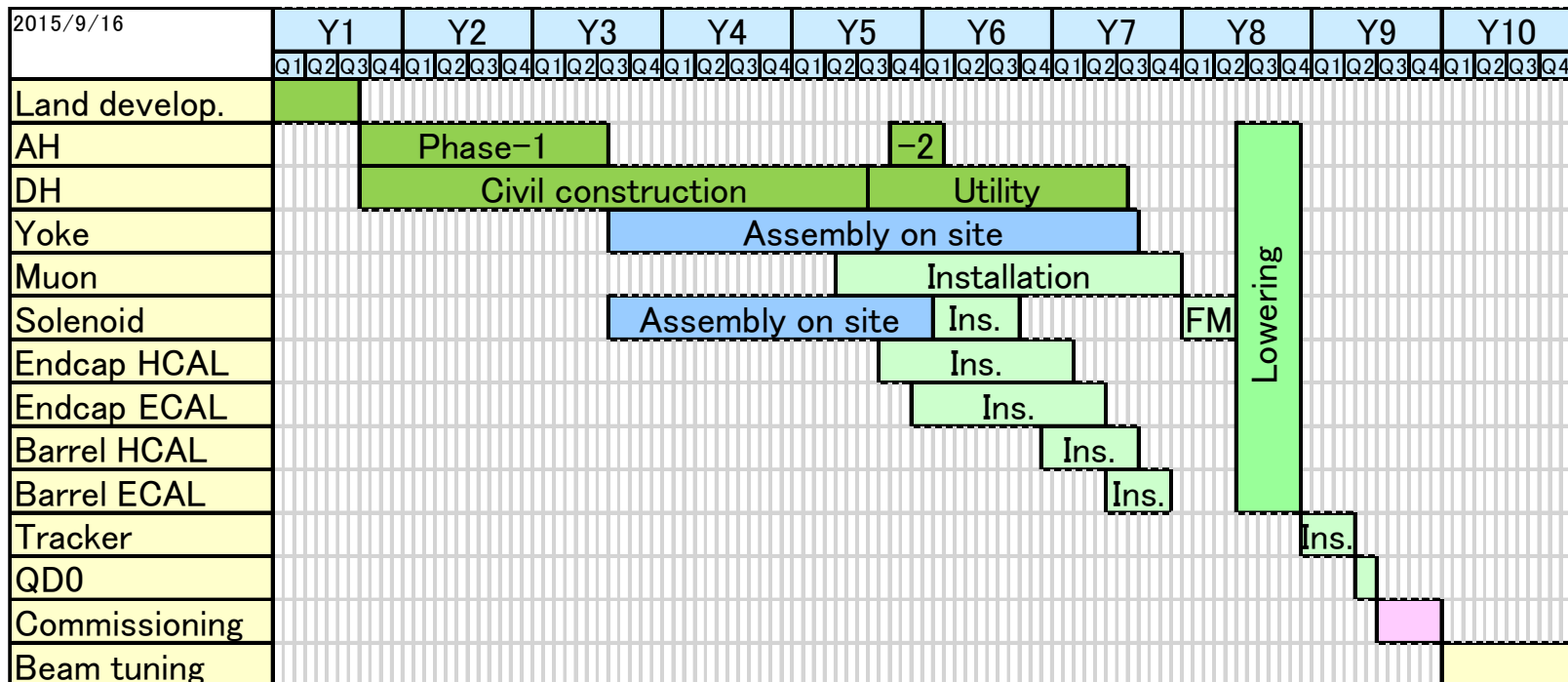
- Design stable but needs full engineering study needed
- Need to review detector services (nothing since 2009)

- There is no official timeline of ILC detector construction defined by LCC
- But we need a working assumption to make detailed designs
- Preparation period of 4 years with R&D budget substantially larger than present level is assumed
- Submission, review, and approval of the proposal and sub-detector TDRs would be in this preparation period (+€)
- Full construction budget will be available at the same time as the ground breaking (T0)





- ILD assembly timeline shown at the ILD Topical Integration Meeting on Oct. 8th
- In this timeline, magnet full-current test can be done only after barrel CAL installation
  - Yoke assembly period should be shortened
  - Solenoid assembly schedule is still uncertain



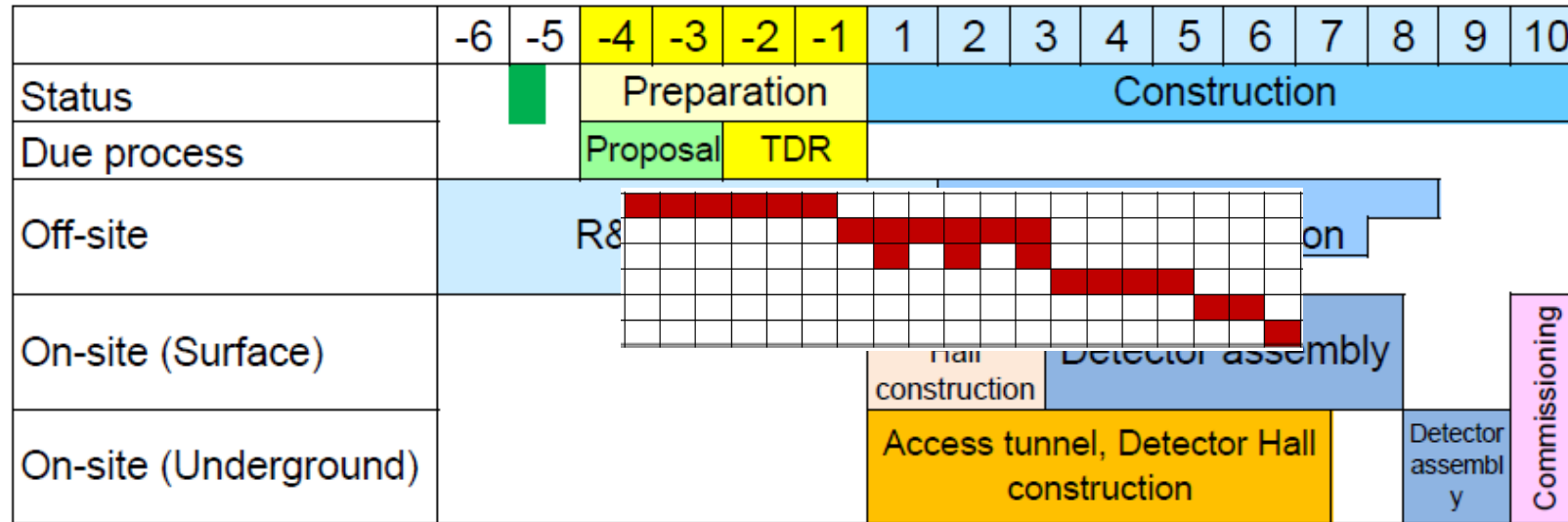
Y. Sugimoto

- There was a study by Toshiba few years ago on the assembly schedule of solenoid
  - ~12 years for on-site winding
  - ~10 years for factory winding (3.5y on-site)

## Lead Time of Manufacture

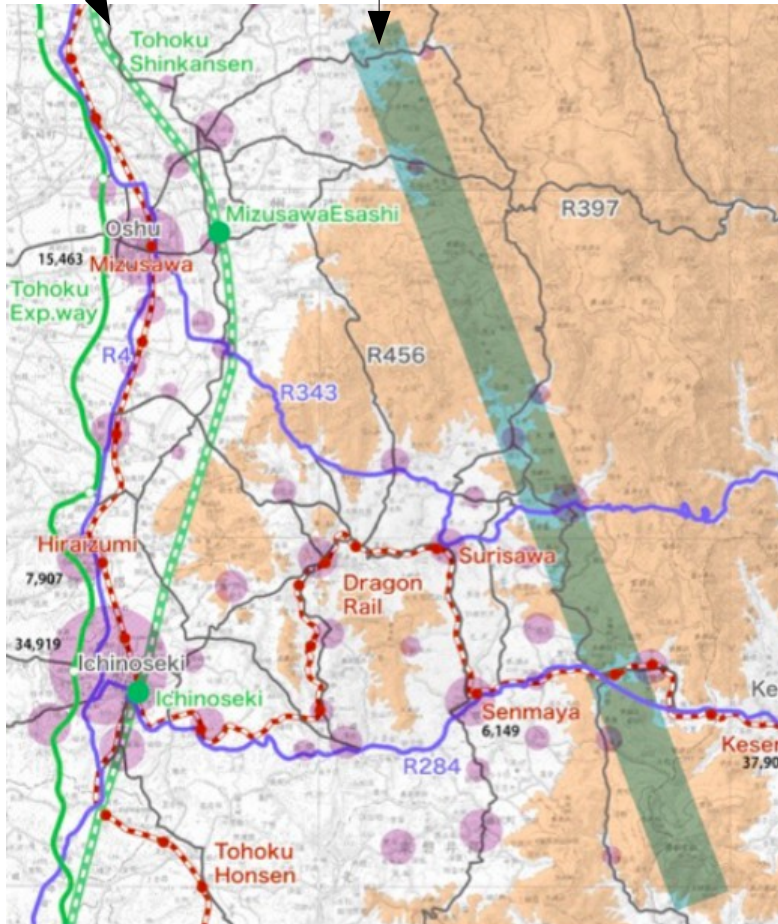
	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025
Assembly Shop Construction													
Experimental Hall Construction													
<b>Factory Winding</b>													
R&D of Coil													
Module Manufacture													
Module Test													
Module Assembly													
Solenoid Performance Test													
Installation into Hall													
<b>On-site Winding</b>													
R&D of Coil													
Module Manufacture													
Module Test													
Module Assembly													
Solenoid Performance Test													
Installation into Hall													

- Assembly on-site should be somewhat shorter
- R&D has to be started before proposal approval
- Bidding and module manufacturing has to be started before the ground breaking (unrealistic?)
- New study will be done in FY2016



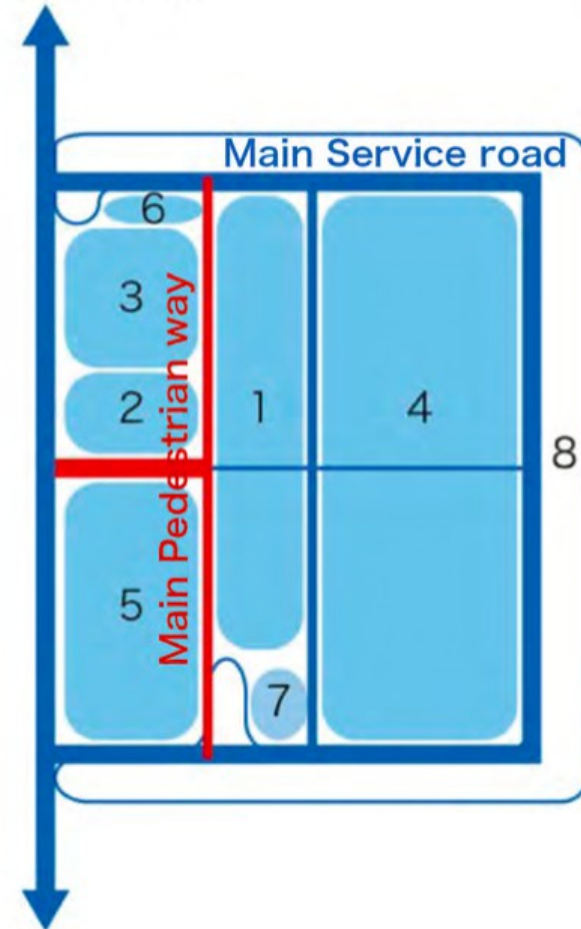
Shinkansen

ILC



Main Campus can/will be about  
30-45 minutes away from IP  
=> Influence on facilities on  
IP Campus

To Shinkansen Station  
City Center



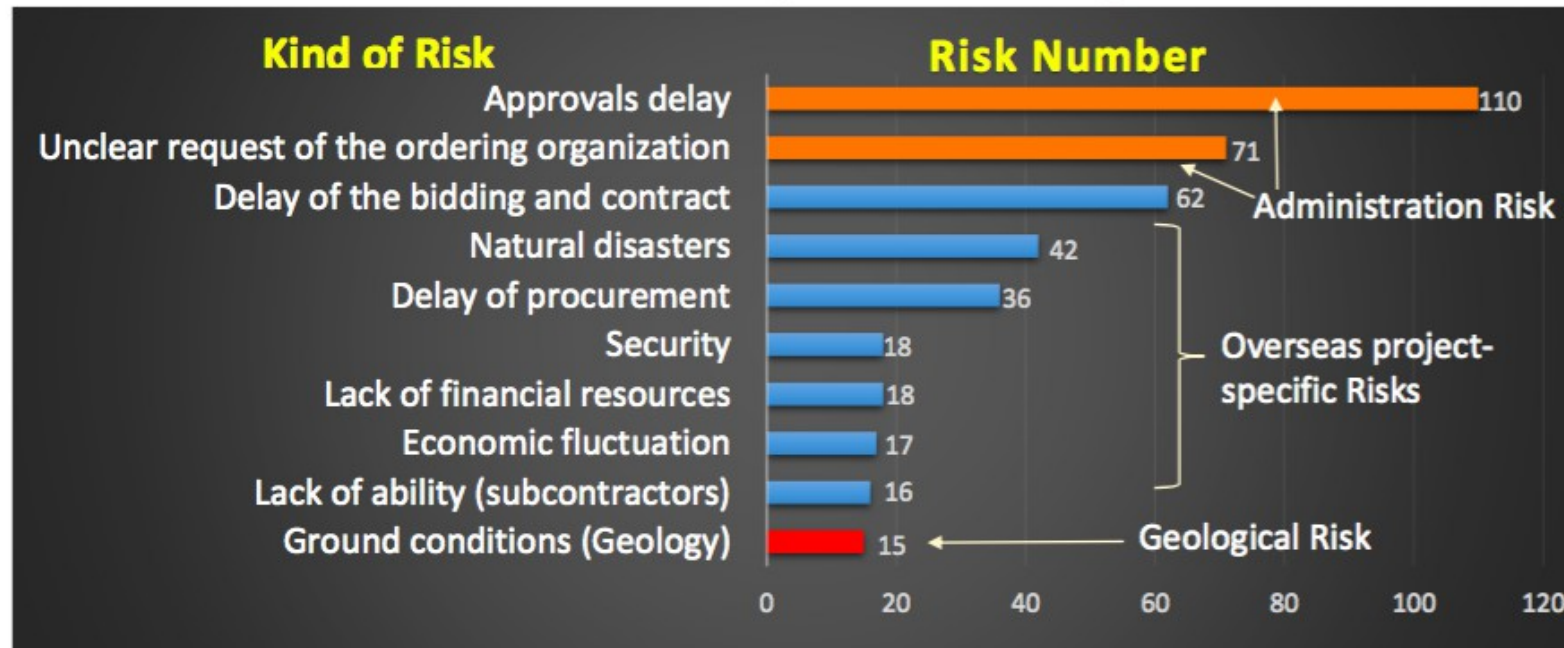
1. Office
2. Conference
3. Service
4. Experimental
5. housing
6. Transportation
7. supply and disposal services
8. buffer green/ open space

*Tokiko Onuki*



## Extraction of Risk Factors in Big Project

- Ex-post Evaluations about **Cost increase** and **Schedule delay** in 377 cases of Japan's ODA Project



*From the public report by JBIC in 2008*

### ■ Administration Risk:

- Approval Delay: **Acquisition of the Construction Site**
- Unclear Request: **Design Specification**, Project budget plan ,etc.
- others: Japanese Budget system, Complicated Decision-making system, etc.

Masanobu Mikyahara

Transport vessel “MOL Comfort” in deep trouble in the Indian Ocean



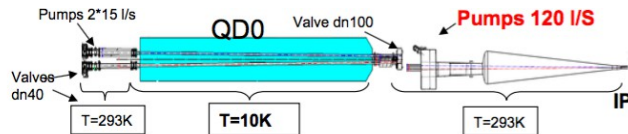
Vessel sunk (finally) in July 2015 ...

*Found by K. Büßer*

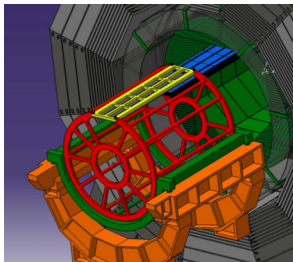
- MDI Activities face a number of open issues and moving targets
- Position of the IP
  - => Size and layout of Assembly Hall
  - => (w/o discussion here) New IP seems to offer more space (but may be more difficult to reach)
- The actual ILD assembly plan depends decisively on the availability of the coil
  - 4 years of R&D prior to construction
  - .... i.e. During a phase in which funding may not yet be abundant
- It is very important to review constantly CFS/MDI activities to be quickly ready at Green Light
- Nice and important overarching activity
- French groups play active role in MDI/CFS activities
- => See next slide



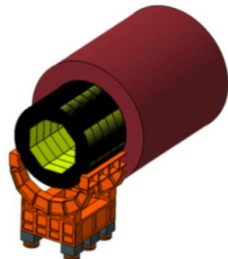
- 3D CAD Model of ILD, validation of detector interfaces and inner region assembly (LAL)
- C. Bourgeois, A. Gonnin



- Vacuum studies (LAL)
- B. Mercier, C. Prevost



- ILD Ecal Assembly and Integration (LLR, LPSC)
- M. Anduze, H. Videau, D. Grondin



- SDHCAL Integration (IPNL)
- C. Inagrio

CEA/Irfu TPC Integration and work on coil (see talks of Gautier and Maxim)

Highly motivated teams despite of little up to no funding



**Backup ....**

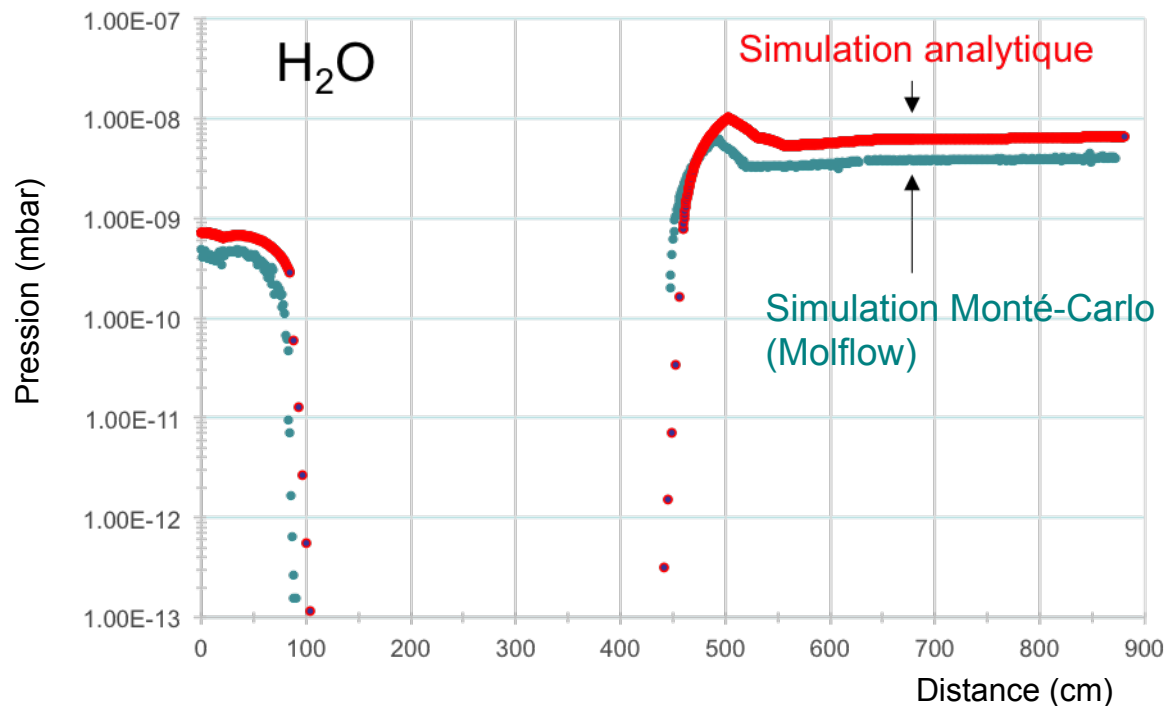
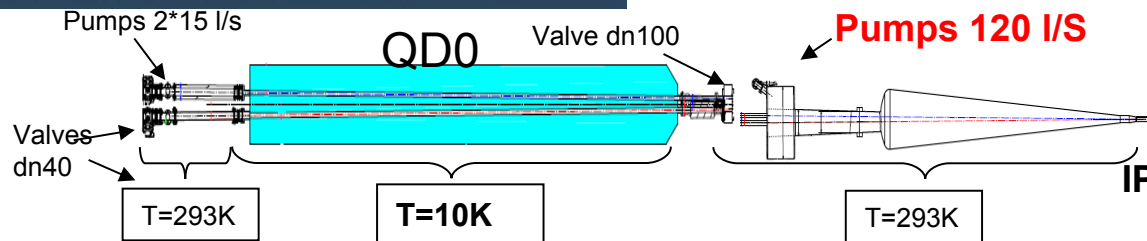
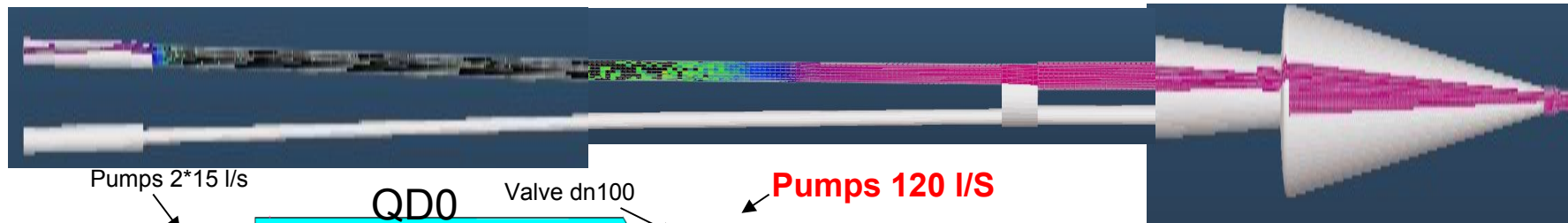
## Technical changes to ILC Baseline

- In the meantime the technical baseline of ILC is also moving forward
  - Change Management Process
- Change Requests with consequences for ILD:
  - CR2: common  $L^*$  at 4.1m ←————— Dedicated ILD study  
Before agreement
  - CR3: vertical shaft assembly at Kitakami ←————— Makes life much easier
  - CR6: adding a stripline BPM to the outgoing beam
  - CR7: adoption of Kitakami as the sole baseline site
- More to come...

## UNDER STATIC CONDITION

QD0 + IP region

Comparison of a Monté-Carlo simulation and analytical simulation for H<sub>2</sub>O



### Without baking

**T=293K**

$$\tau (\text{H}_2) = 5.10^{-12} \text{ mbar.l.s}^{-1}.\text{cm}^{-2}$$

$$\tau (\text{CO}_2) = 1.10^{-13} \text{ mbar.l.s}^{-1}.\text{cm}^{-2}$$

$$\tau (\text{H}_2\text{O}) = 2.10^{-11} \text{ mbar.l.s}^{-1}.\text{cm}^{-2}$$

$$\tau (\text{CO}) = 1.10^{-13} \text{ mbar.l.s}^{-1}.\text{cm}^{-2}$$

After 100h pumping

**T=10K**

$$\sigma (\text{sticking coeff CO, CO}_2, \text{H}_2\text{O}) = 1$$

$$\tau (\text{all gases}) = 0 \text{ mbar.l.s}^{-1}.\text{cm}^{-2}$$

For H<sub>2</sub> pumping by holes in beam screen 2% surface

Without outgassing valves dn40

Study by B. Mercier, C. Prevost LAL

DP0 + IP	Pumps IP 120 l/s	Without baking	5,6 nTorr	H2O	initial
DP0 + IP	No pumps IP	Without baking	120 nTorr	H2O	DP0 and IP volume not separated / Length reduction
DP0 + IP	Neg coating	Baking IP	0,23 nTorr	H2/ H2O	Length reduction
DP0 + IP	Neg saturated	Baking IP	1,4 nTorr	H2O / H2	Length reduction

- Vacuum pump can be removed => 40cm gain => Favorable reply to machine change request
- NEG Coating would assure an excellent **static** vacuum in interaction region  
Would have some operational consequences (heating wires and bakeout after shutdowns)

Technical note written, will be available soon to ILD

- 120 nTorr static **vacuum** doesn't seem however compromise physics (study by R. Karl, DESY)
- Next step is study on **dynamic** vacuum  
Common wisdom says that this is not an issue for linear colliders but will be better to be sure

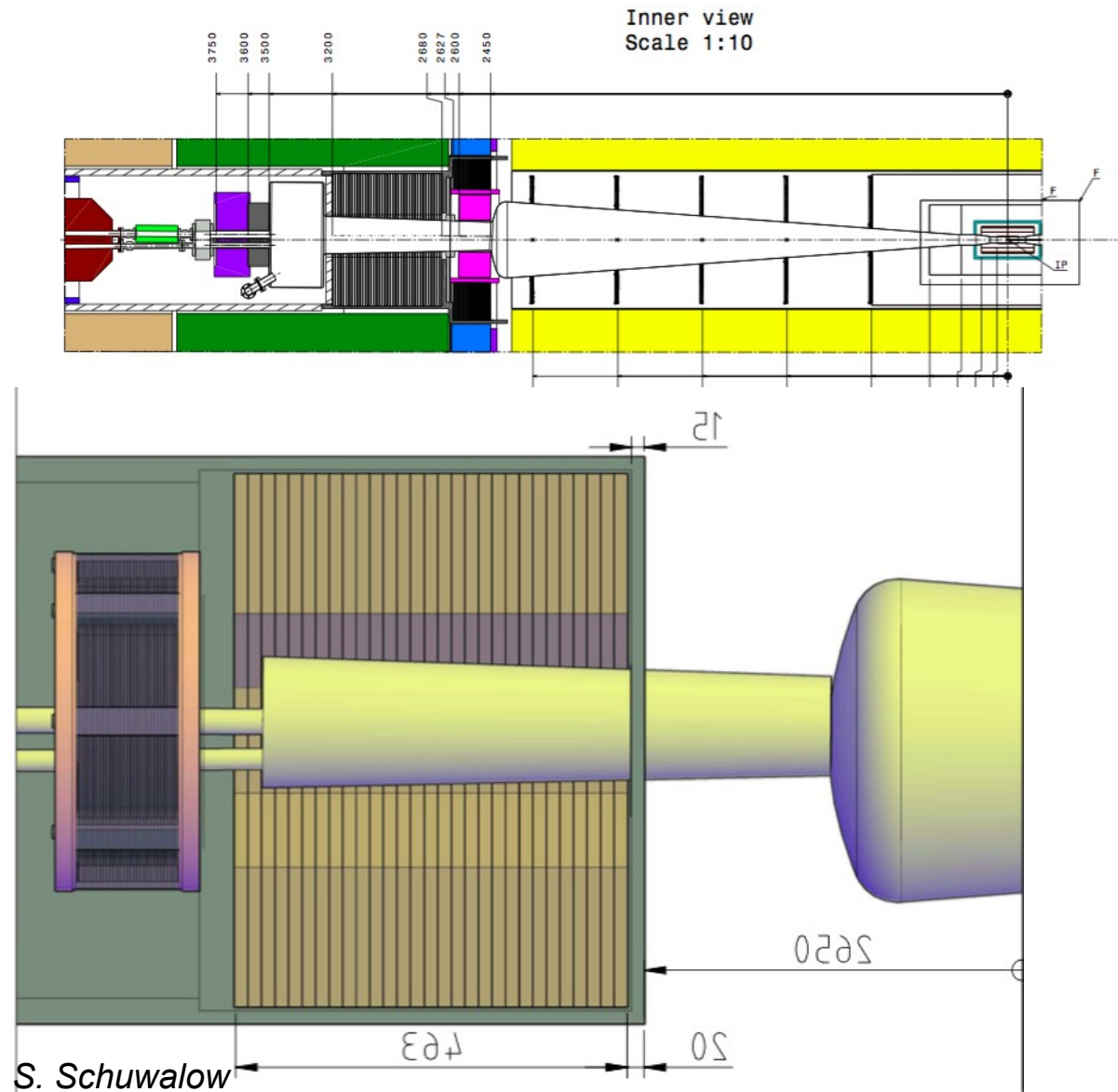


- Conceptual design of LHCAL

- Put BeamCal directly behind LHCAL

To be done:

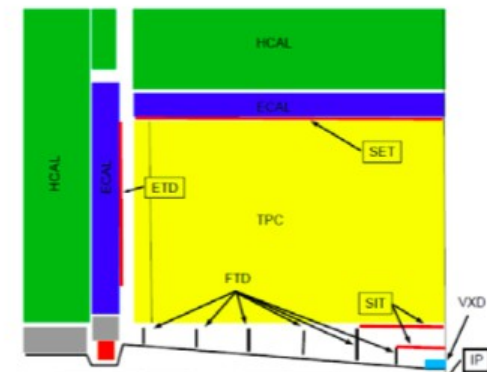
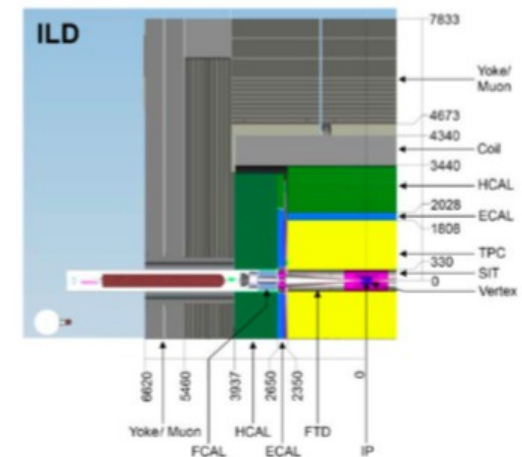
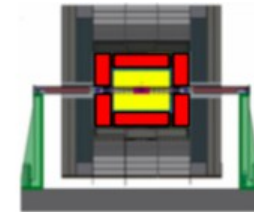
- Check rate of Beamstrahlung pairs, backscattering



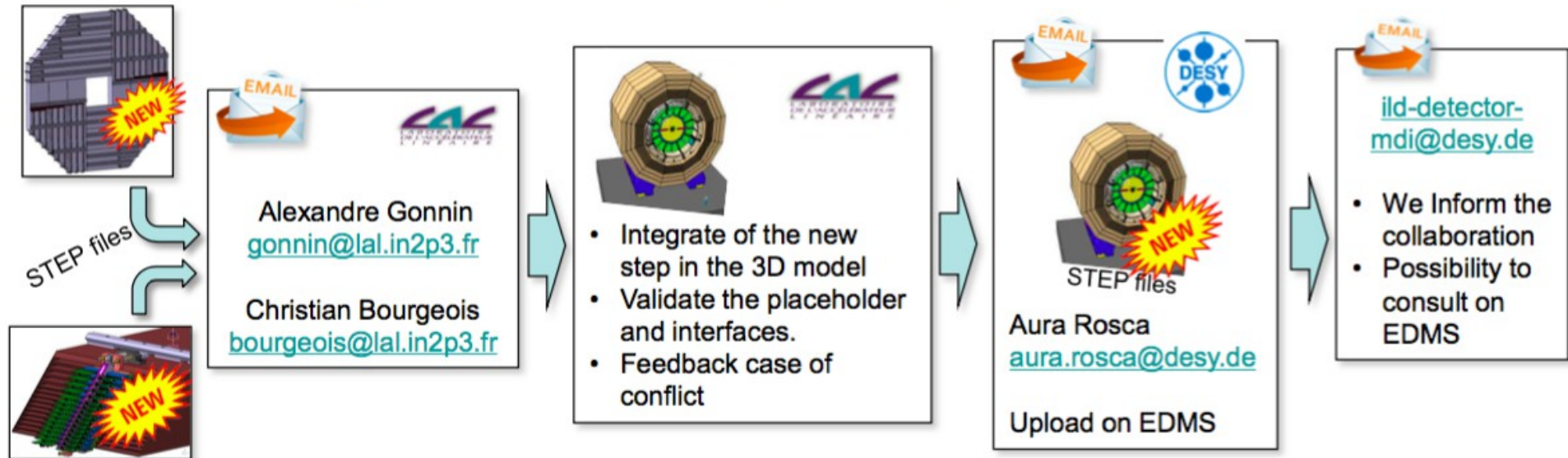
Maintained and validated by C. Bourgeois, A. Gonnin (LAL)

- Reminder : The **DBD 3D CAD model** on CATIA is frozen
- Starting a **new CAD version** with update
  - LAL still collecting all informations (3D model, services placeholders..)
  - for example: in june 2014 SDHCAL update design sent by LPNL*
- **Brainstorming group**, start to work on an update of the ILD detector model: Karsten Buesser (DESY) ; Henry Videau (LLR) ; Roman Poesch (LAL) ; Alexandre Gonnin (LAL) ; Christian Bourgeois (LAL),

*The length and diameter of the experience could change.*

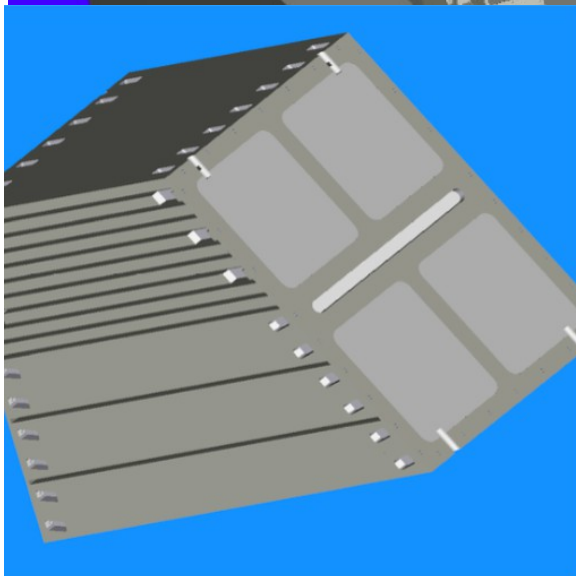
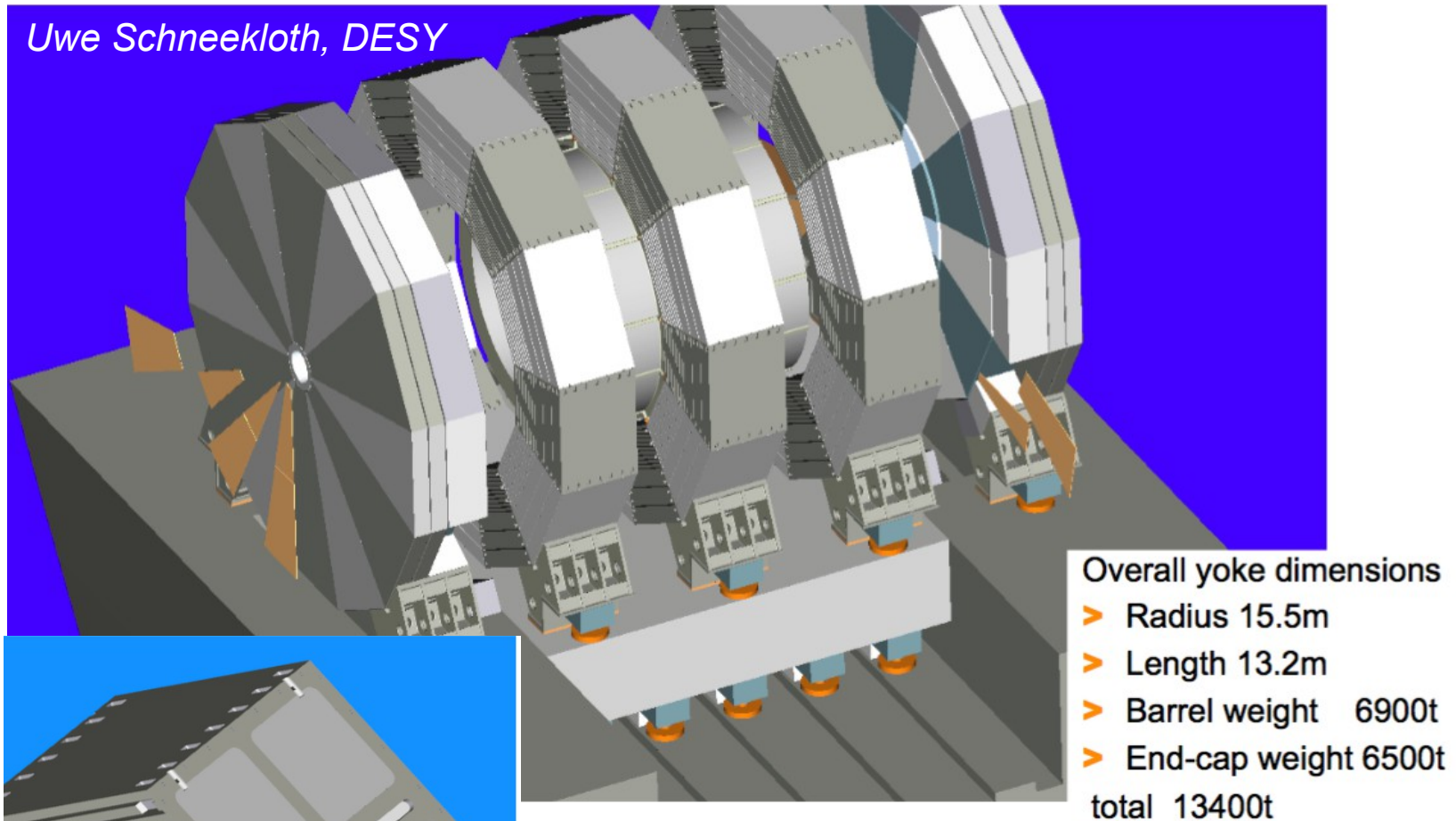


## Process to update 3D model (already the same):



- Updates of the engineering model have to be communicated to Christian Bourgeois and Alexandre Gonnin  
**Otherwise they don't exist!!!!**
- Fill the interface control document

Uwe Schneekloth, DESY

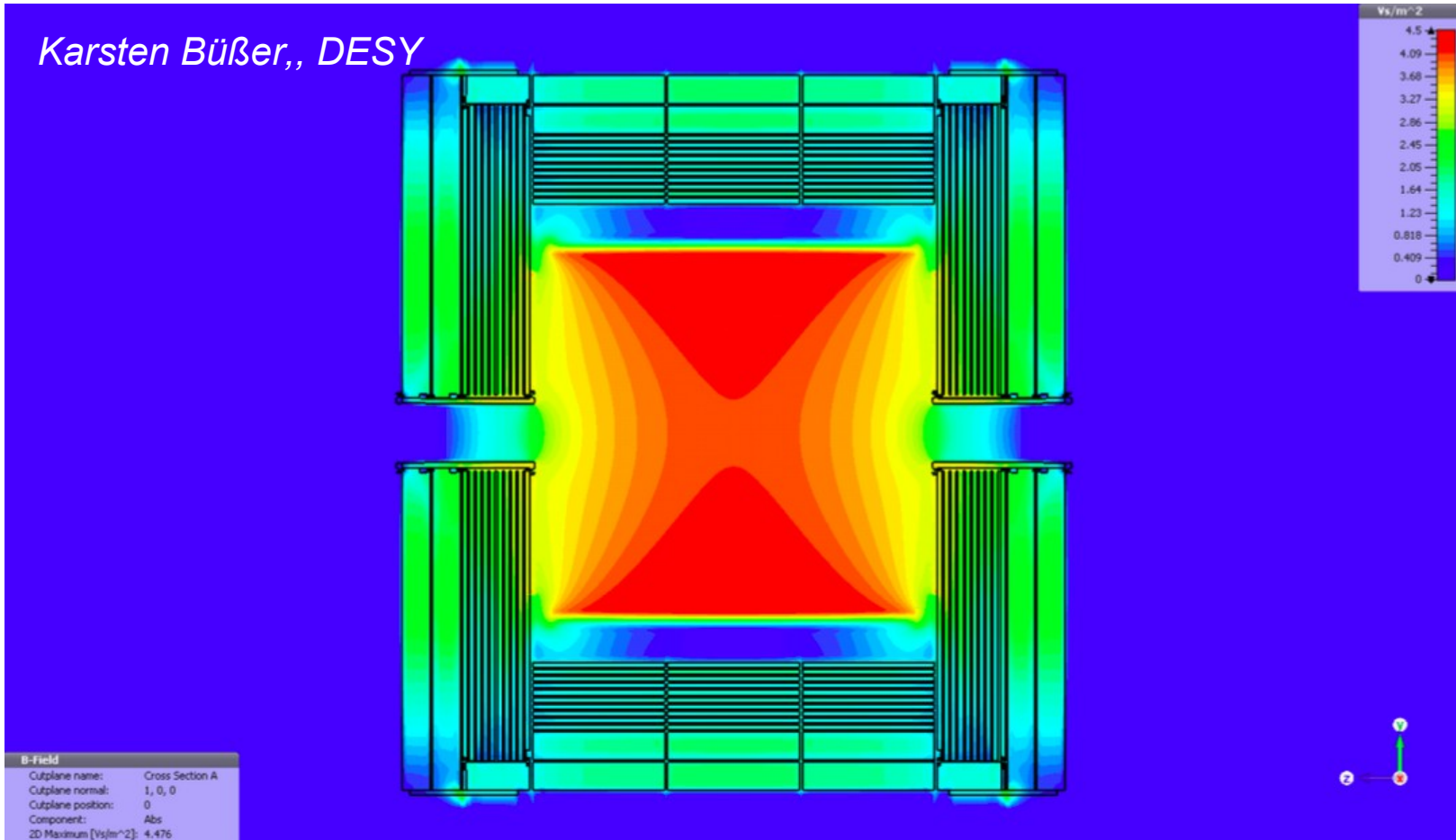


- (Barrel) segment weight 210 t
- May become a transportation issue
- Alternatives with bolted plates under study



Thin(ner) ILD yoke: Remove 60cm of iron w.r.t. DBD design

*Karsten Büßer,, DESY*



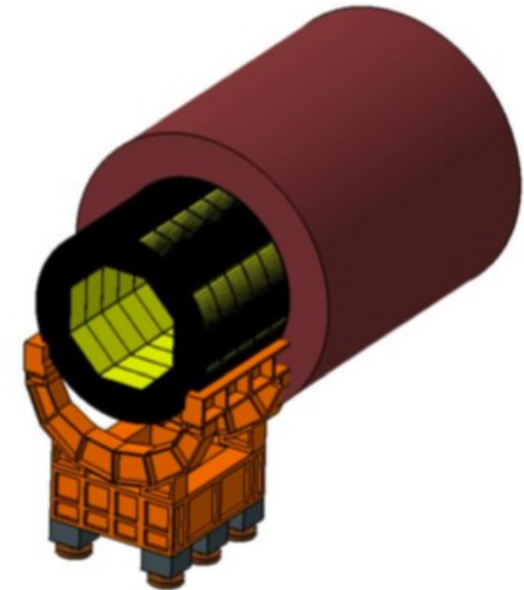
Money savings, Stray field similar to SiD



## Barrel insertion

- Wheels put on the structure one by one
- Barrel with 5 linked wheels on **same sub-structure as ECAL** (similar to CMS)
- Rails inside the yoke
- Insertion « push-pull »
- Fixation inside the yoke on both sides

C. Inagrio, IPNL



Barrel insertion

CMS « enfourneur »

We will have ILC Campus, ILC Experimental hall with surface building  
 Need of auxiliary building?

SDHCAL

■ Wheel assembly in Auxiliary building :

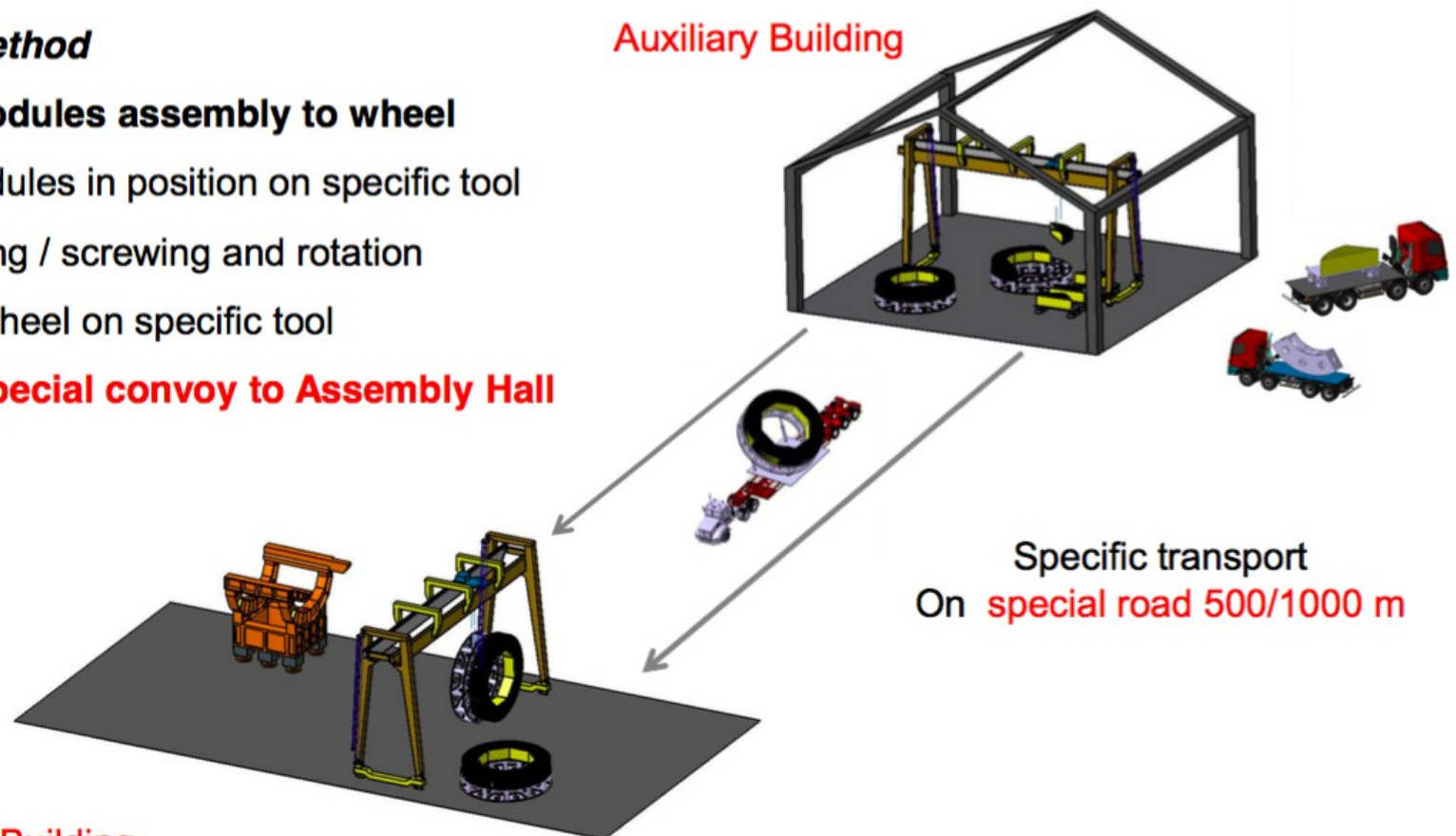
## Building Method

### • Step 1 : Modules assembly to wheel

- 8 modules in position on specific tool
- welding / screwing and rotation

### • Step 2 : Wheel on specific tool

### • Step 3 : **Special convoy to Assembly Hall**

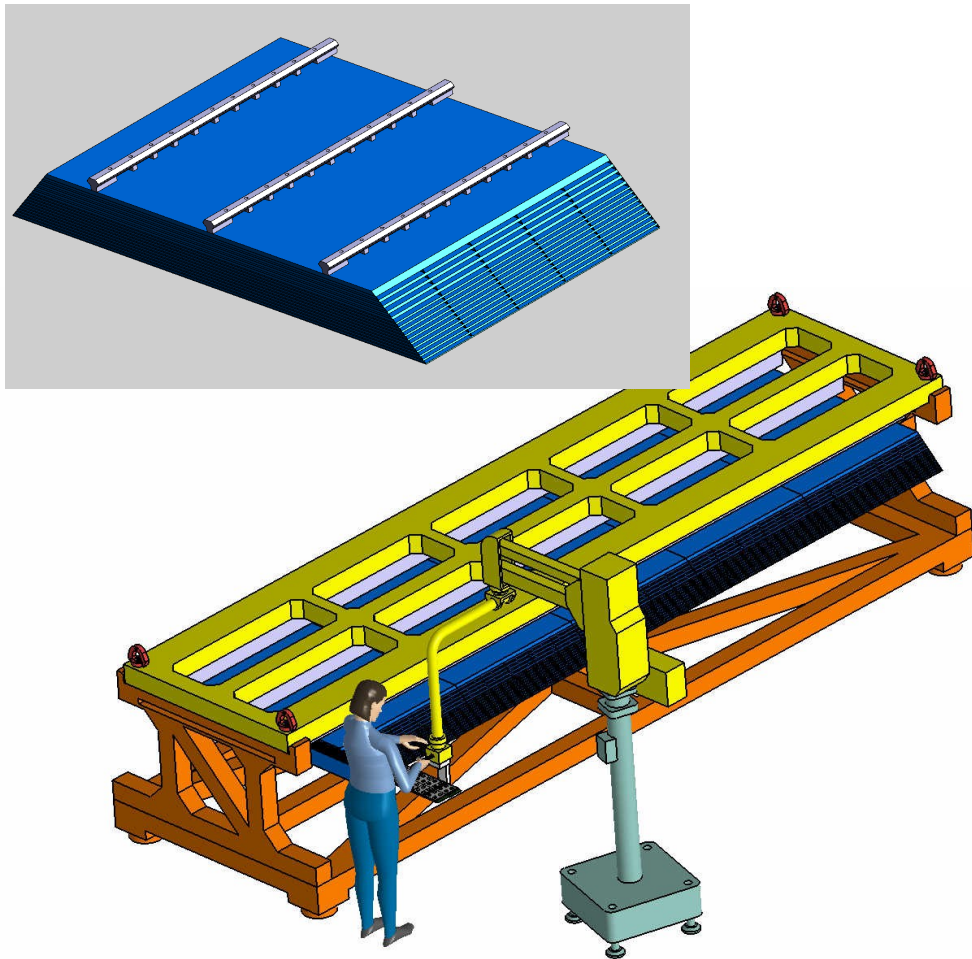


C. Inagrio, IPNL **ILD Building**



## “Off detector” assembly

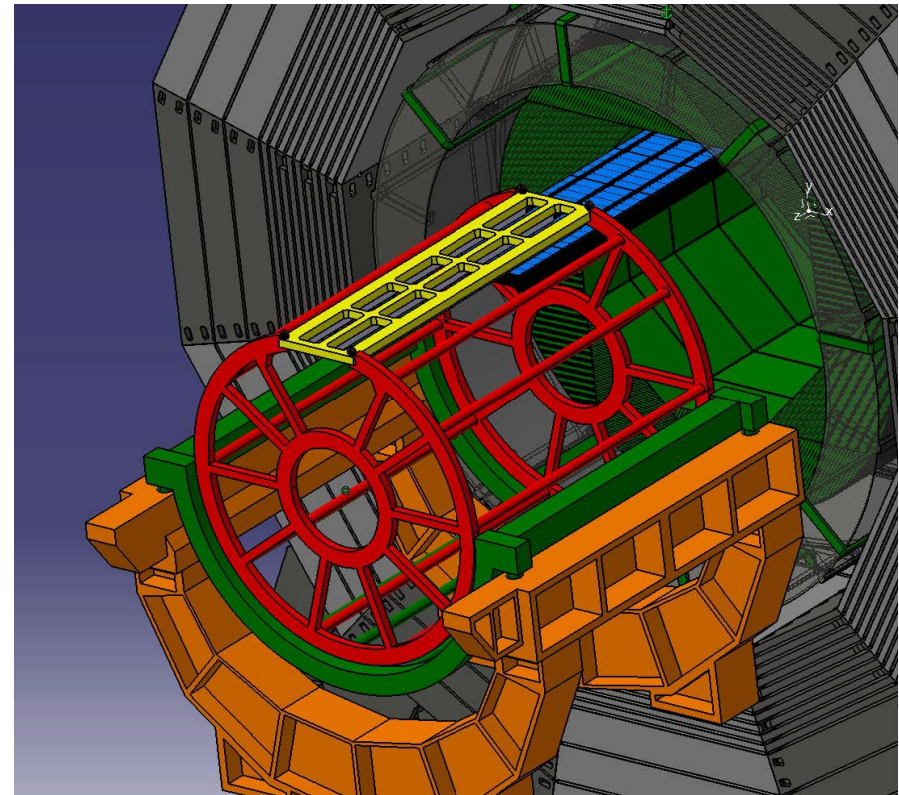
e.g. On ILC Campus



Total modules+cradle can be transported  
By a 10-15t truck

## “On detector” assembly

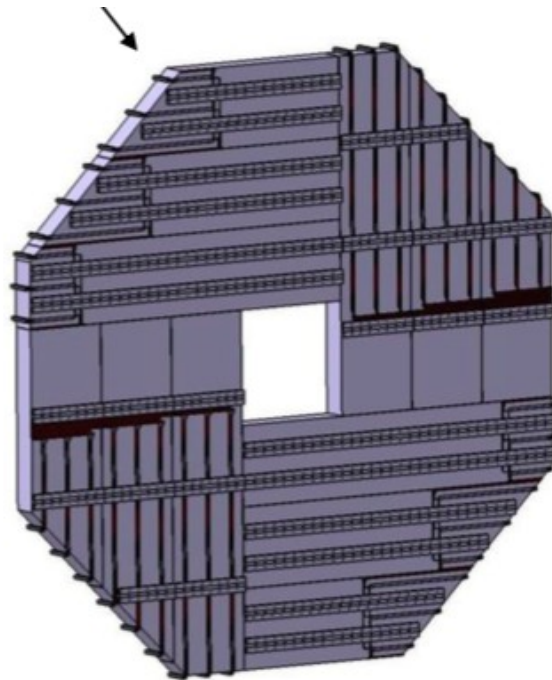
e.g. On ILD in pit



CMS like assembly tool  
To be stored (most likely) in assembly hall

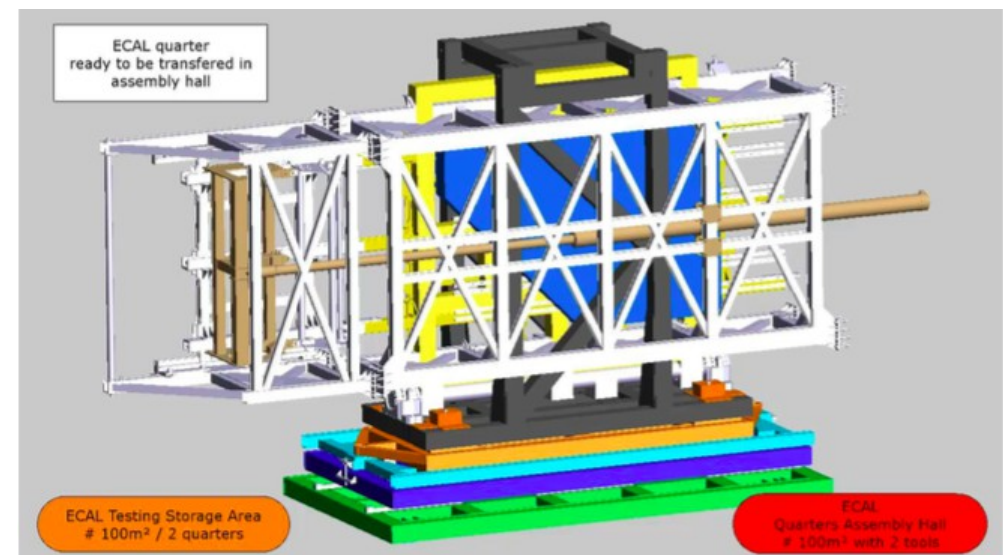
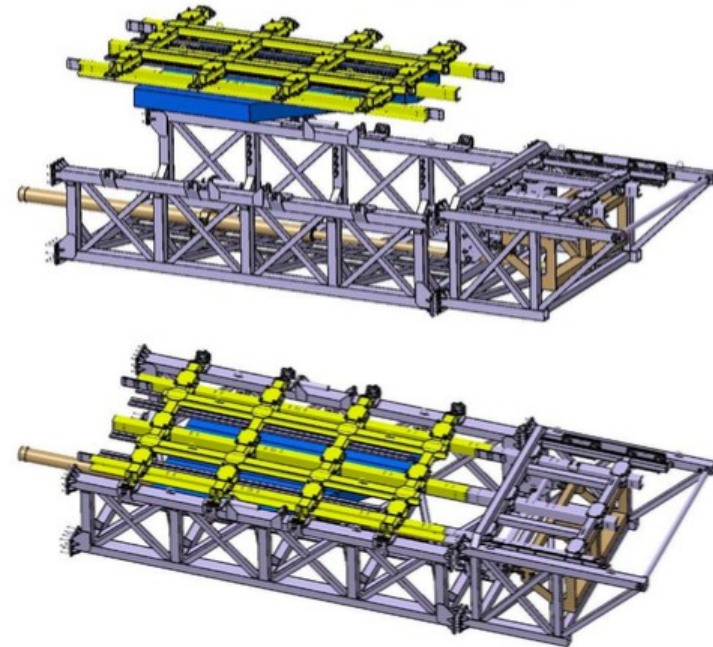
*H. Videau, LLR*

SiW ECAL Endcap

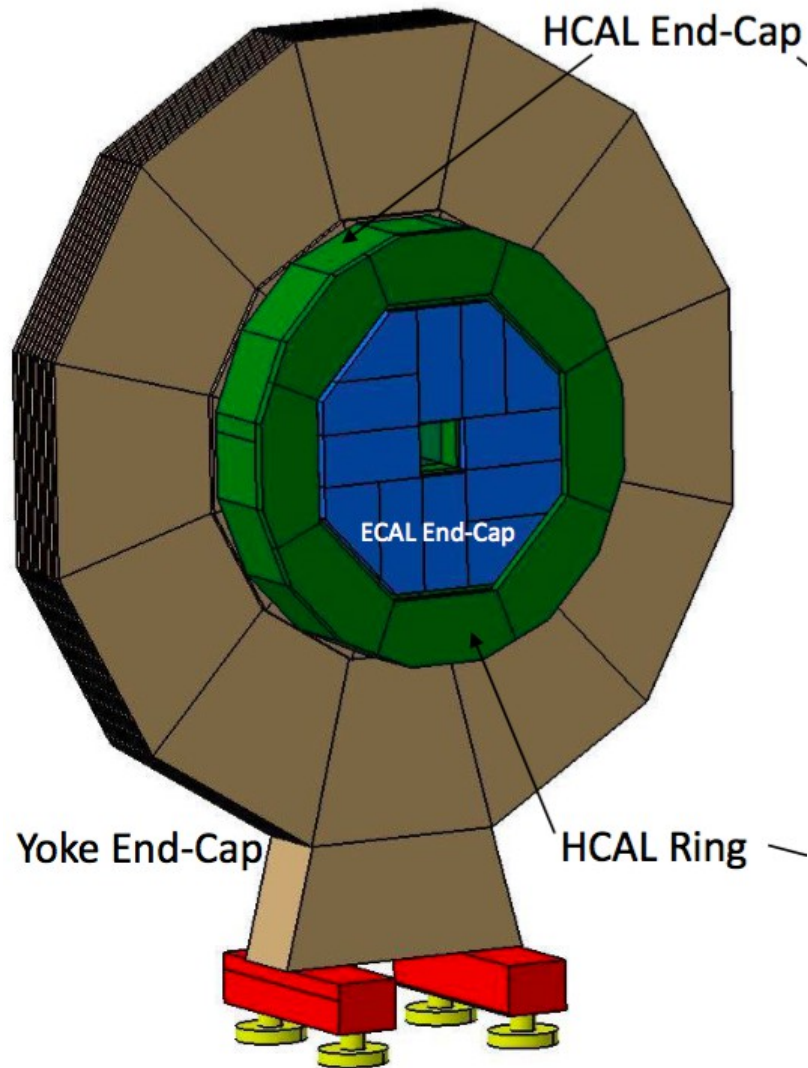


D=4188

Weight 25.5 t  
4 Quadrants



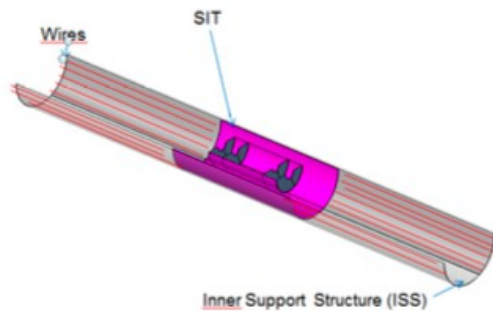




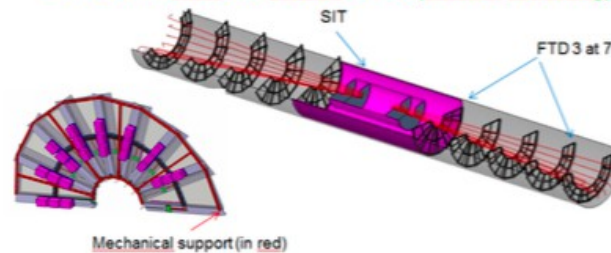
- Combination of many/sall elements discussed so far
- Looks “easy” but requires Well defined interfaces between Detectors
- See Interface Control Document above

## Assembly procedure details :

Reminder

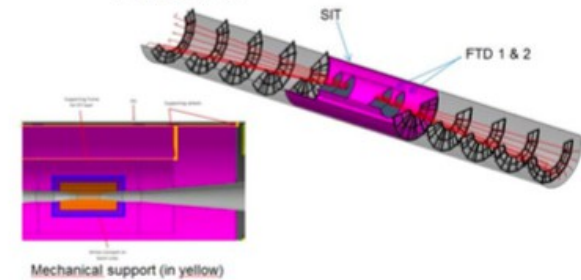


– FTD 3 at 7 fixed and located on ISS (external mounting)



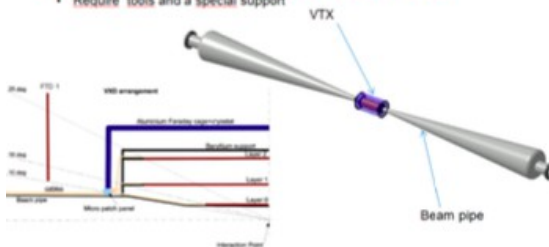
– « Supporting wheels » fixed and located on the ISS

- For the SIT (half part)
- For the FTD 1&2



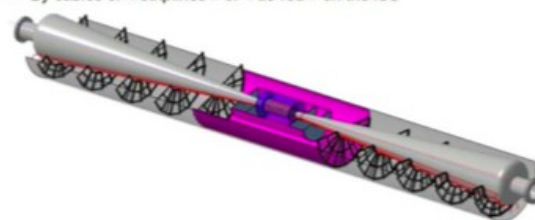
– Beam pipe with VTX assembled and mounted upon 1st assembly: Vertex clamped around the Beam pipe

- Require tools and a special support



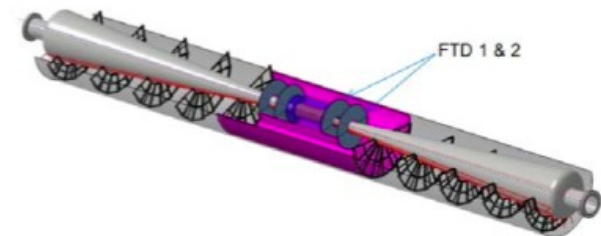
– Beam pipe with VTX assembled and located on the 1st assembly

- By cables or « striplines » or « tie rod » on the ISS



– Close the FTD 1 & 2

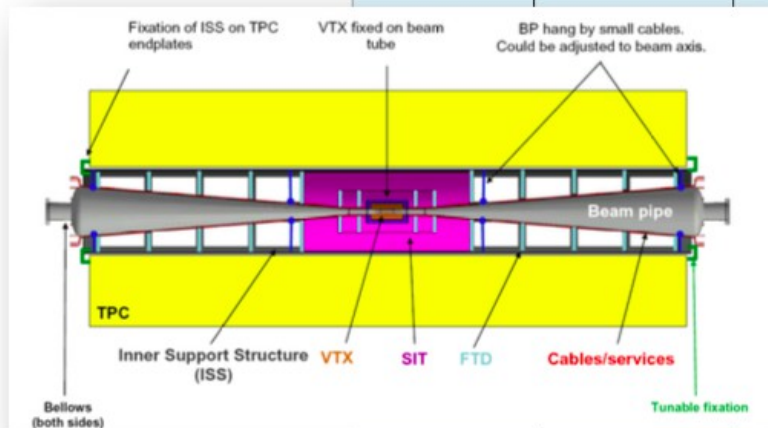
- Located and fixed to the lower half part



- Procedure a la Alexandre Gonnin, LAL
- Similar procedure proposed by groups at IFIC and IFCA (Spain)

Inner region matrix .. to get and overview what we knpwow and what we don't know

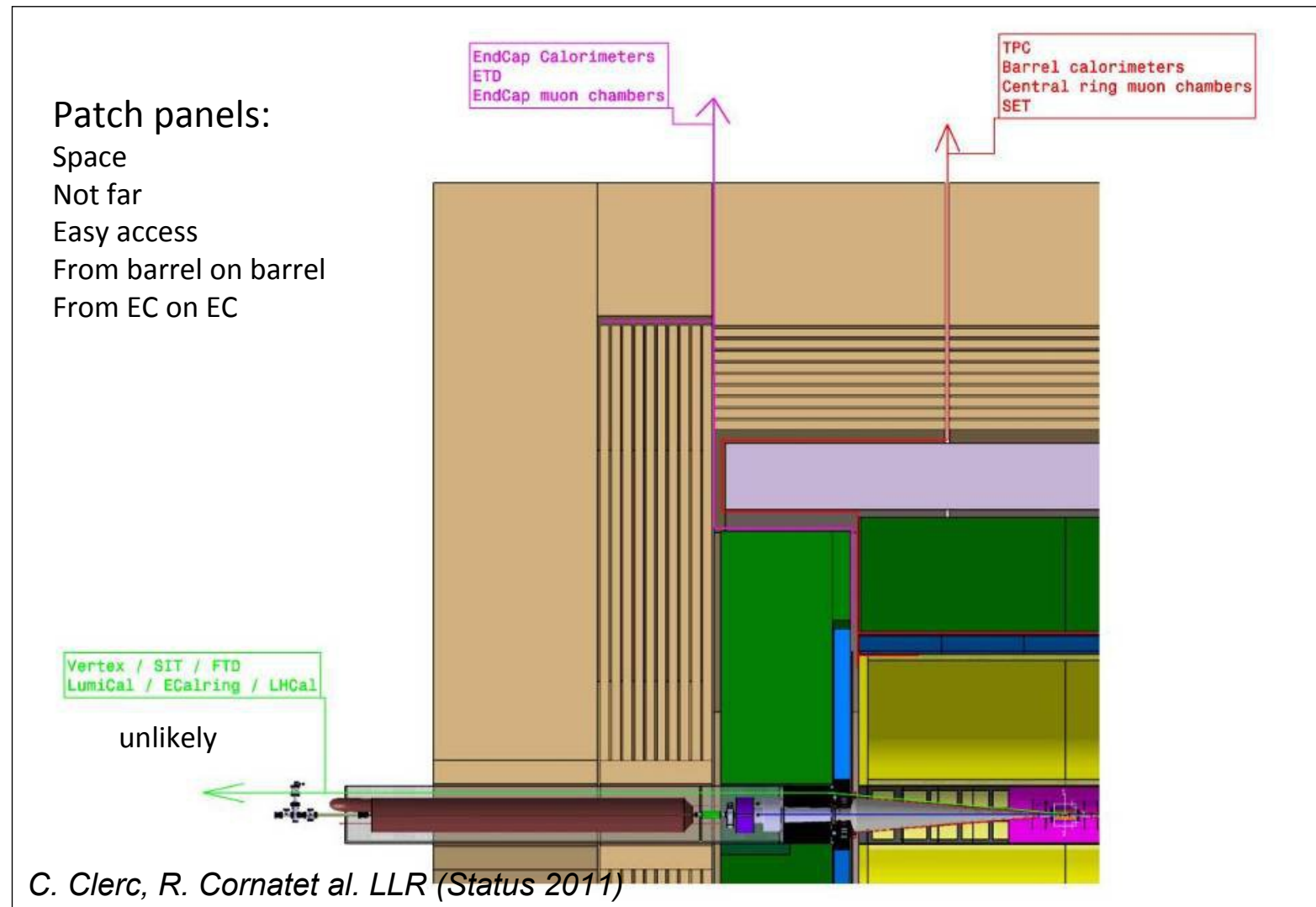
TPC	Tune table fixations with endplates (TBD)					<b>Interfaces design</b>
In charge: Desy						
Position tolerances: Alignment apparatus: laser+ sensors References: TPC (TBC)	<b>ISS (Inner Support Structure)</b> In charge: LAL, Orsay Design: Carbon structure half part or block part (TBD) Power: for alignment apparatus (TBD) Wires: for alignment apparatus; sensor;... Cooling: No	Cables and Tune table fixation (TBD)	Fixation points on external FTD diameter (TBC)	Suspended fixation ? (TBD)	Fixation?	
		<b>Beam Pipe</b> In charge : Design: OK Power: No Wires: no Cooling: No	Support FTD services (wires,...)		Fixation?	Fixed or clamped Beryllium support ?
			<b>FTD 3 at 7</b> In charge : IFIC, Santander? Design: Petals structure Power: Yes Wires: 32 cables/FTD Cooling: ?		FTD 3 fixed on SIT?	
		Position tolerances: Calibration ? References:		<b>FTD 1 &amp; 2</b> In charge : IFIC, Santander? Design: Petals structure Power: Yes Wires: 96 cables/FTD Cooling: ?	FTD 1&2 Fixation ?	
				Position tolerances: (SIT / FTD)= 5µm Calibration ? References:	<b>SIT</b> In charge : ? Design: ? Power: Yes (TBD) Wires: SIT 1=44 cables SIT 2=88 cables Cooling: ?	
					<b>VTX (Vertex)</b> In charge : IPHC Strasbourg Design: Beryllium structure; aluminium Cryostat; Faraday cage Power: No Wires: 30 cables Cooling: ?	
<b>Technical values</b>						



TBC : To Be Confirm  
 TBD : To Be Design

A. Gonnin, LAL

A reminder



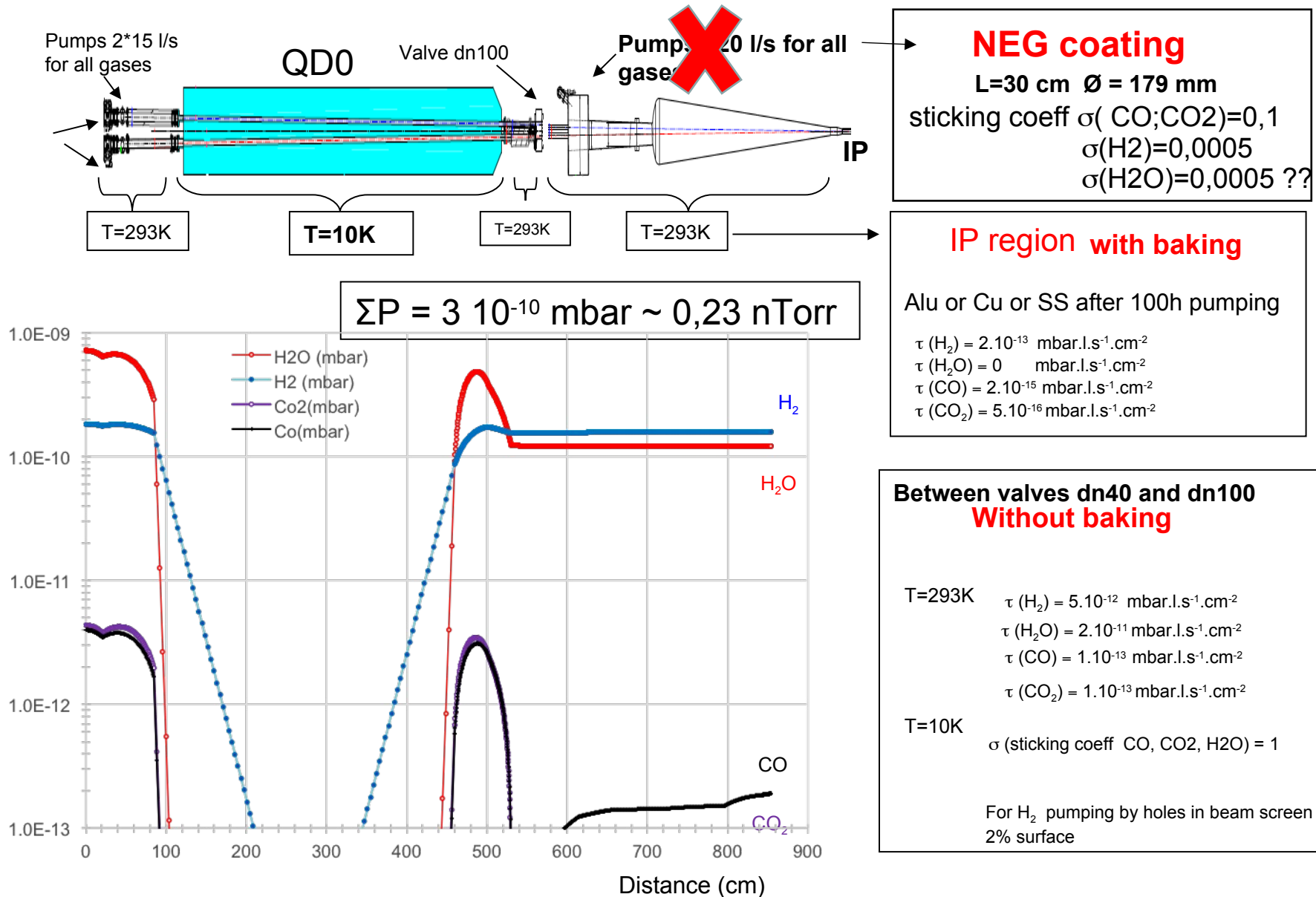
Study for DBD needs regular update!!!!

- Discussion on MDI issues reveal a big number of moving targets
  - IP Point where?  
=> Assembly halls
  - Harmonising time scales
  - A lot depends on the fabrication of the solenoid
- Big parts need considerable work planning and money before project approval
  - e.g. Solenoid but also (in our case) calorimeters
- Regular MDI/CFS Meetings are important for an efficient ramp-up after green light
- All sub- detectors proposed by European Groups and in particular by French groups have developed first ideas on assembly procedure
- Basically no dedicated funding available since ILC/ILD as a project doesn't exist
- All e.g. Engineers work for ILD since they find it challenging and consider it as “their” future project



## UNDER STATIC CONDITION

QD0 + IP region



## Proposal of an Interface Control Document (ICD):

Purpose of this document is:

- To know and record technical details of each subdetector
- To understand the consequences at the interfaces (gap, fixations, weight, )
- Follow up of different progress
- 

One document by sub detector

Enter all technical details you know today (dimensions, weight, attachment points, center of gravity, positioning constraints, services, power consumption, thermal dissipation, integration specifications, )

Items may be missing (Please help actively to improve the document)

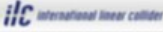
Each ICD will evolve during the phase of study.

*They are not casted in stone yet*



- ICD will become backbone of ILD Design study!!!
- Status will be monitored at ILD Integration meetings

<b>1. INTRODUCTION.....</b>	<b>3</b>
1.1. SCOPE OF THE DOCUMENT .....	3
1.2. APPLICABLE DOCUMENTS (AD).....	3
1.3. REFERENCE DOCUMENTS (RD).....	3
1.4. LIST OF ABBREVIATIONS .....	3
<b>2. GENERAL INTERFACE DESCRIPTION .....</b>	<b>4</b>
<b>3. MECHANICAL INTERFACE.....</b>	<b>4</b>
3.1. COORDINATE SYSTEM.....	4
3.2. MECHANICAL CONCEPT .....	4
3.3. CRITICAL DIMENSIONS.....	4
3.4. WEIGHTS .....	4
3.5. POSITIONING AND ALIGNMENT CONSTRAINS .....	4
<b>4. ELECTRICAL INTERFACE.....</b>	<b>4</b>
4.1. BLOCK DIAGRAM .....	4
4.2. CONNECTION DIAGRAM .....	4
4.3. LIST OF CONNECTORS.....	5
4.4. CABLING AND CONNECTING SHEETS .....	5
4.5. ELECTRICAL CIRCUIT OF THE GROUNDING .....	5
4.6. POWER CONSUMPTION .....	5
4.7. OTHER ELECTRICAL INTERFACES.....	5
<b>5. FLUID INTERFACE (IF NEEDED).....</b>	<b>5</b>
5.1. GAS SYSTEM INTERFACE.....	5
5.2. LIQUID SYSTEM INTERFACE.....	6
<b>6. THERMAL INTERFACE (IF NEEDED).....</b>	<b>6</b>
<b>7. CABLING .....</b>	<b>6</b>
<b>8. POWER .....</b>	<b>6</b>
<b>9. TEST INTERFACES.....</b>	<b>6</b>

	Interface Control Document Template	Ref. :	Page : 1/7
		Ed. : 1 Rev. : 0 Date:	

## Interface Control Document Template

XXXXXXXX (Sub detector name)

Prepared by	Signature	Accepted by	Signature

Approved by	Function	Date	Signature

Summary	
Annexes	

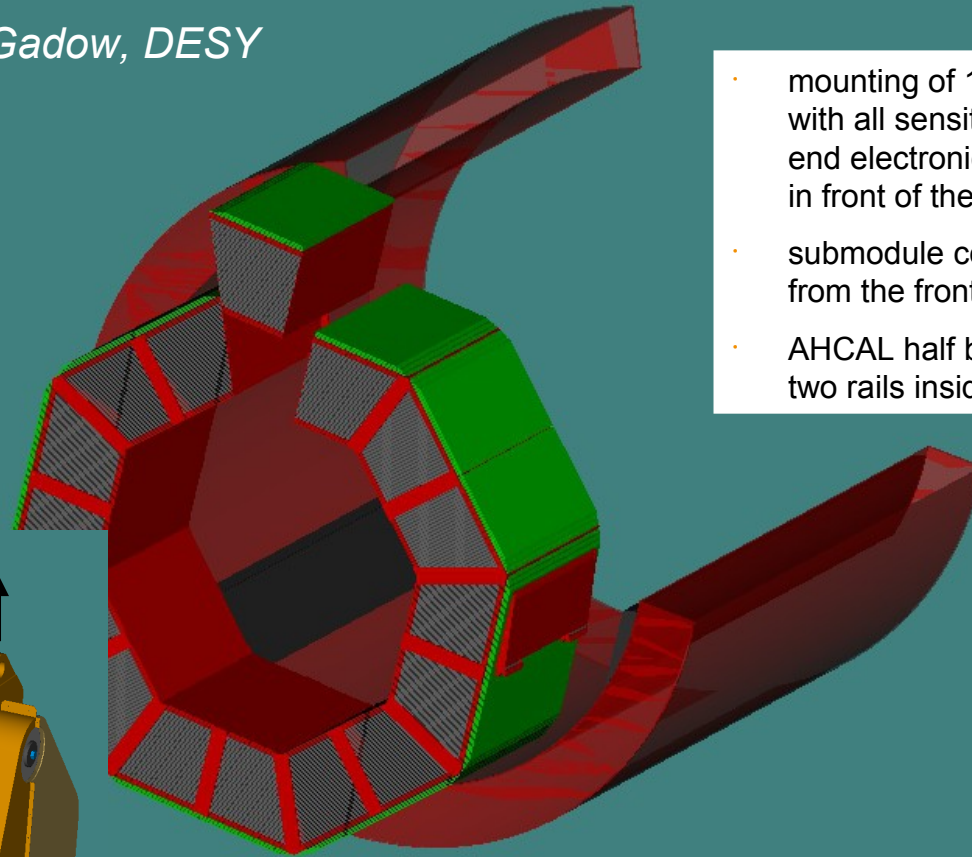
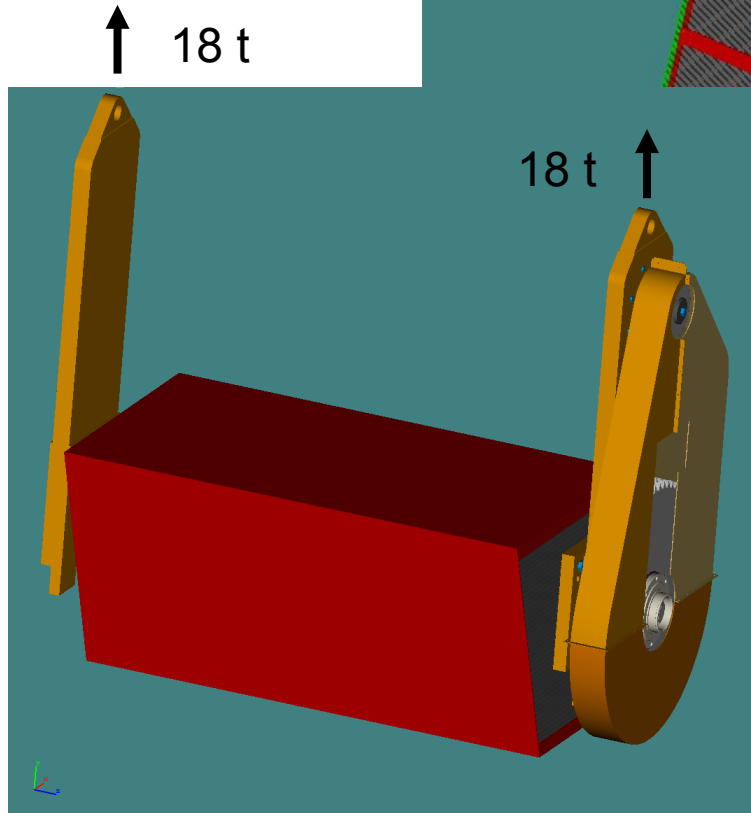
Document Change Record				
Edition	Revision	Date	Modified pages	Observations
1	0			

Distribution	See Distribution list at the end of this document
--------------	---

Template V1.0

*Karsten Gadow, DESY*

- mounting of 16 AHCAL submodules with all sensitive layers and front end electronics to a full half barrel in front of the cryostat
- submodule connection by plates from the front and back side
- AHCAL half barrel is supported by two rails inside the cryostat vessel

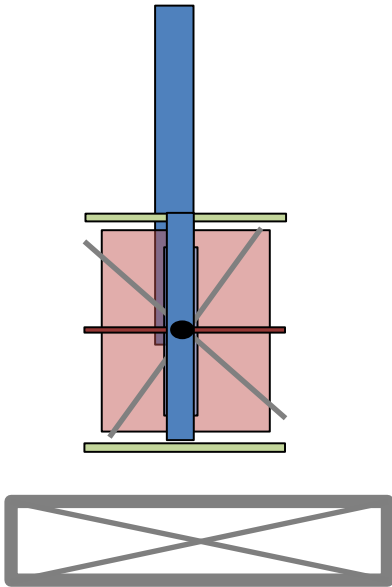


- Assembly of AHCAL inside detector hall !!



Two alternatives considered for assembly:

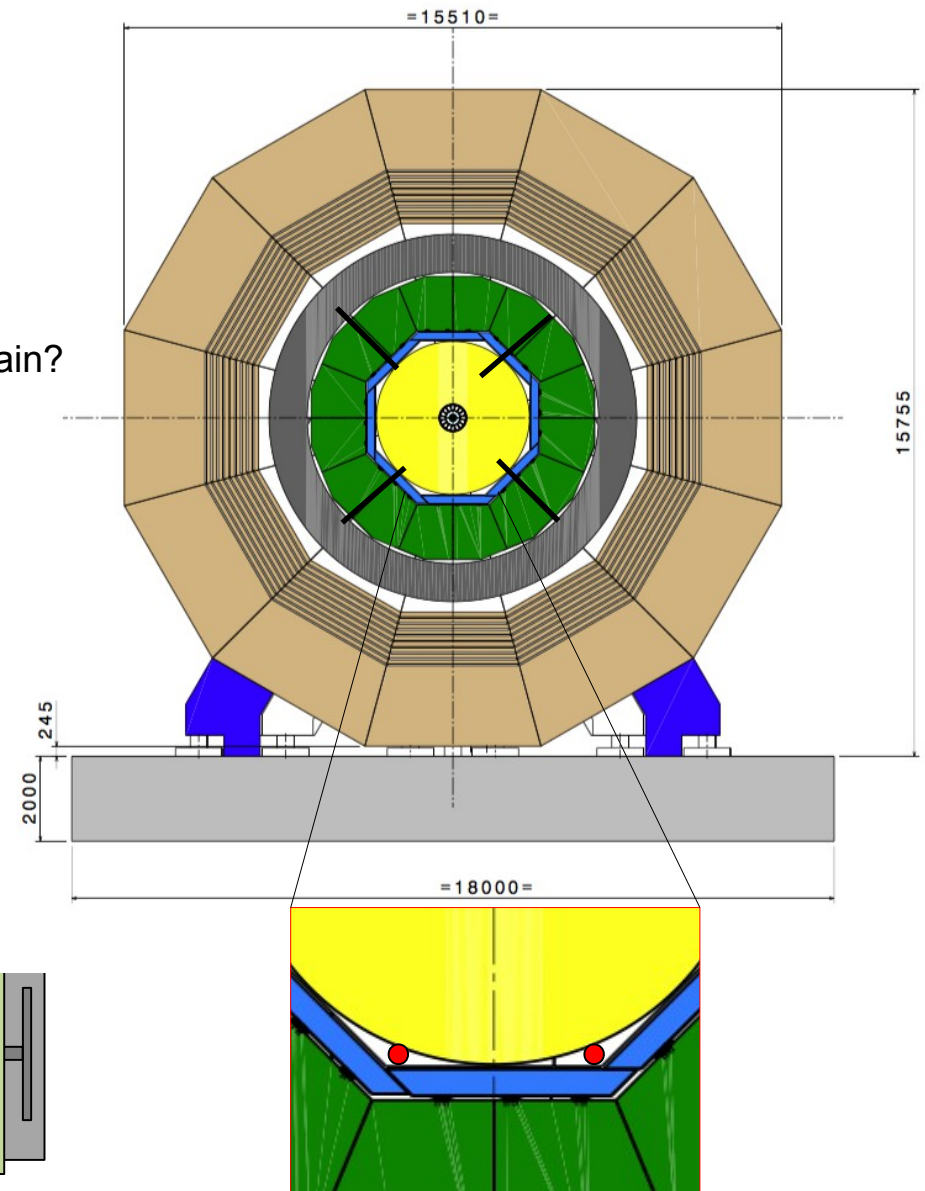
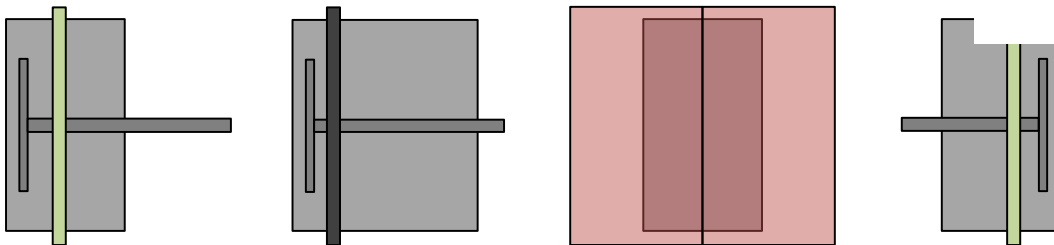
Vertical assembly:



Carbon bands

- How many?
- Size?
- How about longitudinal strain?

Horizontal assembly:



Space for rails?



## Study Effects of excitation by Earthquake-waves on AHCAL

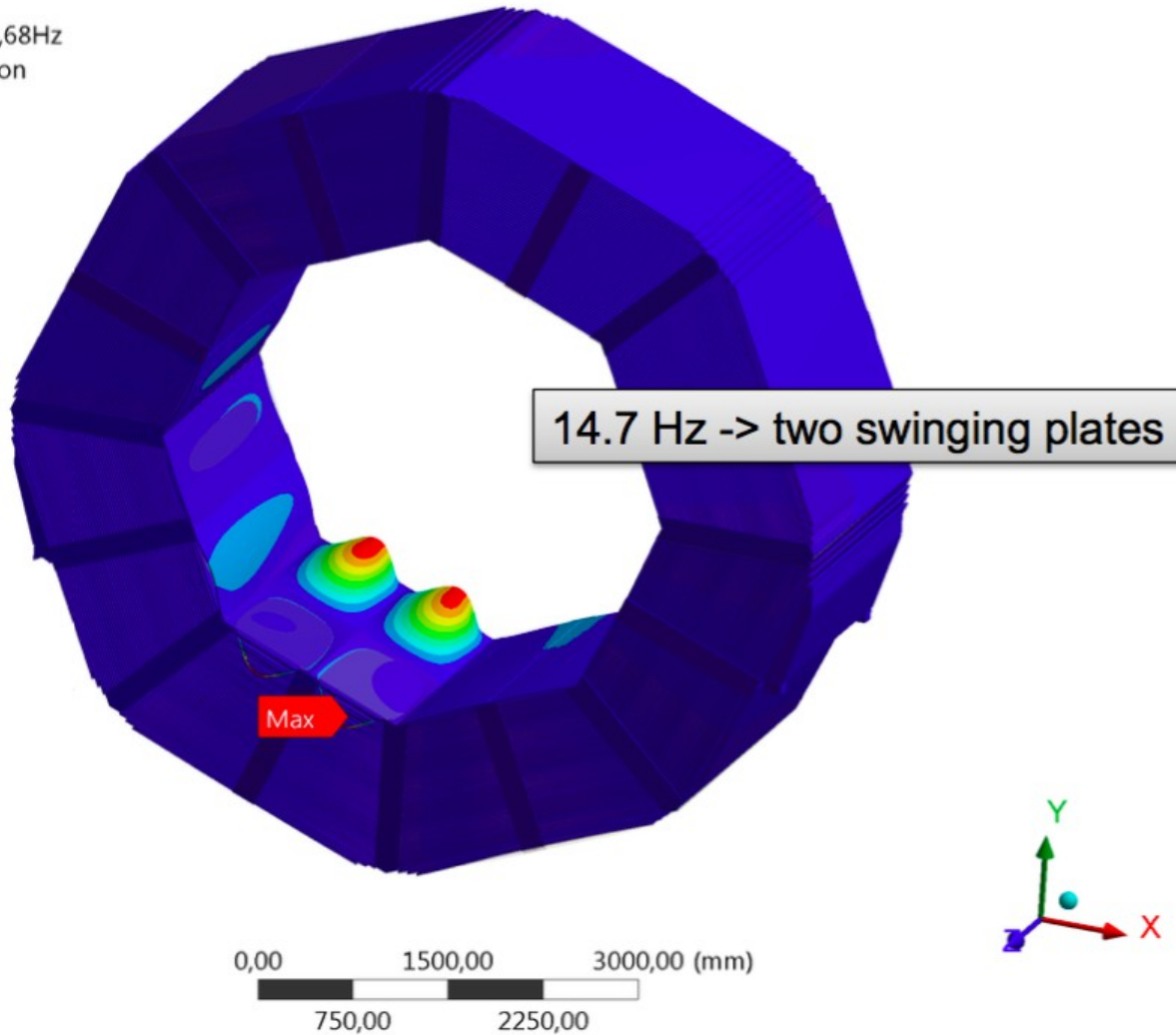
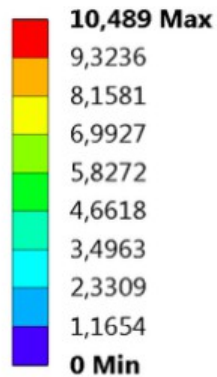
### D: Modal

Total Deformation\_14,68Hz

Type: Total Deformation

Frequency: 14,676 Hz

Unit: mm



- Detailed simulation  
Different frequencies  
Excite different pieces  
(Different eigenfrequencies)
- Need to find compromise on detail
- Need to extend study to ILD as a whole

K. Gadow, F. Sefkow, DESY

Objective: mechanical setup understanding

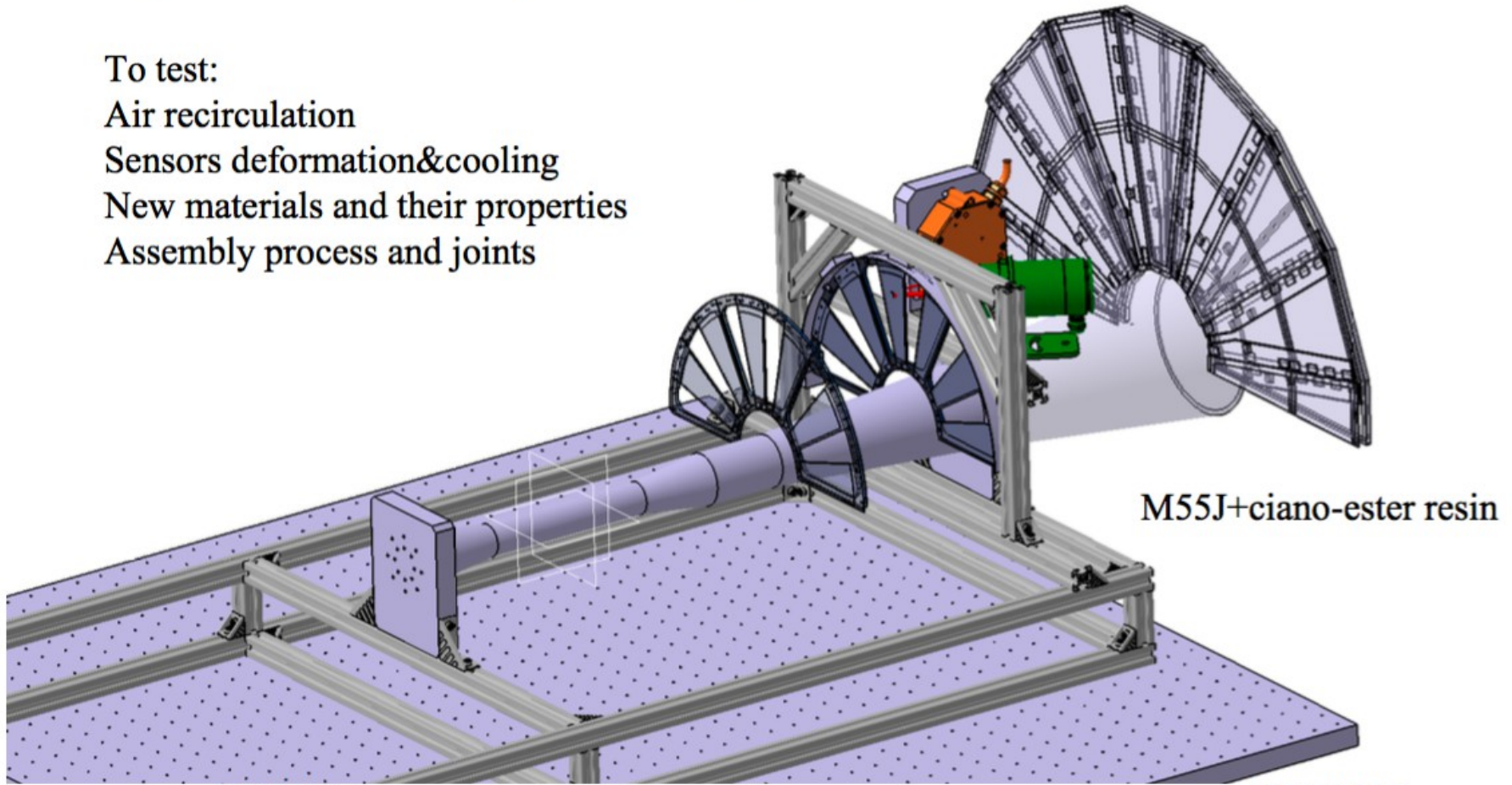
To test:

Air recirculation

Sensors deformation&cooling

New materials and their properties

Assembly process and joints



*IFIC and IFCA, Spain*

## Ecal

Per 2/3 stave

LDA	1 per column		5 per module			
			cable ∟	mm <sup>2</sup>	Nbre	S total cm <sup>2</sup>
LV to DC/DC 48>3,3 V	48V/2A	2*1,5mm <sup>2</sup> of Cu	8	50,24	15	7,536
HT depletion Wafers 250 V/50μA par layer	250V/1,5mA		8	50,24	15	7,536
Signal/CC	flat multiwire cable 2,54 mm	0,05cm <sup>2</sup> *10wires		50,67	15	7,6
Ground line		1 per module ?		210	3	6,3
			Total			28,972

Cu cm <sup>2</sup> /cable	Cu total	
0,03	0,45	5,97%
0,03	0,45	5,97%
	0	0,00%
	6,3	100,00%
	7,2	24,85%

Where is the optical conversion of signal ?

## AHcal

For one half octant

per layer	(48 per 1/2 module)		cable ∟	mm <sup>2</sup>	Nbre	S total cm <sup>2</sup>
1Power	50v 0,3 μA per channel 276 ch/layer	2*5pins SAMTEC IPL1 0,64mm	10*2,54 mm	50,67	48	24,3216
1 HDMI			8	50,24	48	24,1152
Ground line		1 per Half octant		210	1	2,1
			Total			50,5368

Cu cm <sup>2</sup> /cable	Cu total	
0,032	1,536	6,32%
0,03	1,44	5,97%
2,1	2,1	100,00%
	5,076	